

# INAx180 Low- and High-Side Voltage Output, Current-Sense Amplifiers

## 1 Features

- Common-mode range ( $V_{CM}$ ):  $-0.2\text{ V}$  to  $+26\text{ V}$
- High bandwidth: 350 kHz (A1 devices)
- Offset voltage:
  - $\pm 150\text{ }\mu\text{V}$  (maximum) at  $V_{CM} = 0\text{ V}$
  - $\pm 500\text{ }\mu\text{V}$  (maximum) at  $V_{CM} = 12\text{ V}$
- Output slew rate: 2 V/ $\mu\text{s}$
- Accuracy:
  - $\pm 1\%$  gain error (maximum)
  - $1\text{-}\mu\text{V}/^\circ\text{C}$  offset drift (maximum)
- Gain options:
  - 20 V/V (A1 devices)
  - 50 V/V (A2 devices)
  - 100 V/V (A3 devices)
  - 200 V/V (A4 devices)
- Quiescent current: 260  $\mu\text{A}$  maximum (INA180)

## 2 Applications

- Motor control
- Battery monitoring
- Power management
- Lighting control
- Overcurrent detection
- Solar inverters

## 3 Description

The INA180, INA2180, and INA4180 (INAx180) current sense amplifiers are designed for cost-optimized applications. These devices are part of a family of current-sense amplifiers (also called current-shunt monitors) that sense voltage drops across current-sense resistors at common-mode voltages from  $-0.2\text{ V}$  to  $+26\text{ V}$ , independent of the supply voltage. The INAx180 integrate a matched resistor gain network in four, fixed-gain device options: 20 V/V, 50 V/V, 100 V/V, or 200 V/V. This matched gain resistor network minimizes gain error and reduces the temperature drift.

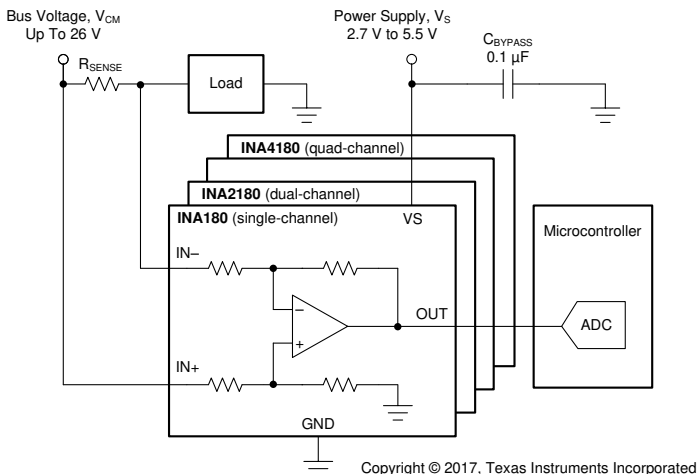
All these devices operate from a single 2.7-V to 5.5-V power supply. The single-channel INA180 draws a maximum supply current of 260  $\mu\text{A}$ ; whereas, the dual-channel INA2180 draws a maximum supply current of 500  $\mu\text{A}$ , and the quad channel draws a maximum supply current of 900  $\mu\text{A}$ .

The INA180 is available in a 5-pin, SOT-23 package with two different pin configurations. The INA2180 is available in 8-pin, VSSOP and WSON packages. The INA4180 is available in a 14-pin, TSSOP package. All device options are specified over the extended operating temperature range of  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ .

### Packaging Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)   |
|-------------|------------|-------------------|
| INA180      | SOT-23 (5) | 2.90 mm × 1.60 mm |
| INA2180     | VSSOP (8)  | 3.00 mm × 3.00 mm |
|             | WSON (8)   | 2.00 mm × 2.00 mm |
| INA4180     | TSSOP (14) | 5.00 mm × 4.40 mm |

- (1) For all available packages, see the package option addendum at the end of the data sheet.



**Typical Application Circuit**



## Table of Contents

|  |           |   |           |
|--|-----------|---|-----------|
| <b>1 Features</b> .....                        | <b>1</b>  | 8.2 Functional Block Diagrams.....                        | <b>16</b> |
| <b>2 Applications</b> .....                    | <b>1</b>  | 8.3 Feature Description.....                              | <b>18</b> |
| <b>3 Description</b> .....                     | <b>1</b>  | 8.4 Device Functional Modes.....                          | <b>19</b> |
| <b>4 Revision History</b> .....                | <b>2</b>  | <b>9 Application and Implementation</b> .....             | <b>21</b> |
| <b>5 Device Comparison</b> .....               | <b>4</b>  | 9.1 Application Information.....                          | <b>21</b> |
| <b>6 Pin Configuration and Functions</b> ..... | <b>4</b>  | 9.2 Typical Application.....                              | <b>25</b> |
| <b>7 Specifications</b> .....                  | <b>7</b>  | 9.3 Power Supply Recommendations.....                     | <b>26</b> |
| 7.1 Absolute Maximum Ratings.....              | <b>7</b>  | 9.4 Layout.....   | <b>27</b> |
| 7.2 ESD Ratings.....                           | <b>7</b>  | <b>10 Device and Documentation Support</b> .....          | <b>31</b> |
| 7.3 Recommended Operating Conditions.....      | <b>7</b>  | 10.1 Documentation Support.....                           | <b>31</b> |
| 7.4 Thermal Information.....                   | <b>7</b>  | 10.2 Receiving Notification of Documentation Updates..... | <b>31</b> |
| 7.5 Electrical Characteristics.....            | <b>8</b>  | 10.3 Support Resources.....                               | <b>31</b> |
| 7.6 Typical Characteristics.....               | <b>9</b>  | 10.4 Trademarks.....                                      | <b>31</b> |
| <b>8 Detailed Description</b> .....            | <b>16</b> | 10.5 Electrostatic Discharge Caution.....                 | <b>31</b> |
| 8.1 Overview.....                              | <b>16</b> | 10.6 Glossary.....  | <b>31</b> |

## 4 Revision History

| <b>Changes from Revision G (April 2020) to Revision H (July 2022)</b>  | <b>Page</b> |
|--|-------------|
| • Updated the numbering format for tables, figures, and cross-references throughout the document.....                                | <b>1</b>    |
| • Moved the <i>Power Supply Recommendations</i> and <i>Layout</i> sections to the <i>Application and Implementation</i> section..... | <b>26</b>   |
| • Changed pin 3 in <a href="#">Figure 9-9</a> from: IN+2 to: IN+1.....   | <b>28</b>   |

| <b>Changes from Revision F (March 2019) to Revision G (April 2020)</b> | <b>Page</b> |
|--|-------------|
| • Added INA2180 8-pin WSON package to the data sheet.....              | <b>1</b>    |

| <b>Changes from Revision E (July 2018) to Revision F (March 2019)</b>                                    | <b>Page</b> |
|--|-------------|
| • Added new paragraph regarding phase reversal to end of <i>Input Differential Overload</i> section..... | <b>19</b>   |

| <b>Changes from Revision D (March 2018) to Revision E (July 2018)</b> | <b>Page</b> |
|---|-------------|
| • Added B version devices to <i>Device Comparison</i> table.....      | <b>4</b>    |

| <b>Changes from Revision C (December 2017) to Revision D (March 2018)</b> | <b>Page</b> |
|---|-------------|
| • Changed INA4180 device from preview to production data (active).....    | <b>1</b>    |
| • Added new Figure 25 for INA4180 .....                                   | <b>9</b>    |
| • Added new Figure 28 for INA4180 .....                                   | <b>9</b>    |

| <b>Changes from Revision B (November 2017) to Revision C (December 2017)</b>   | <b>Page</b> |
|--|-------------|
| • Changed INA2180 device from preview to production data (active).....   | <b>1</b>    |
| • Added "Both Inputs" to Figure 21 title .....   | <b>9</b>    |
| • Added new Figure 24 for INA2180.....   | <b>9</b>    |
| • Added new Figure 25 placeholder for INA4180.....   | <b>9</b>    |
| • Added new Figure 27 for INA2180.....   | <b>9</b>    |
| • Added new Figure 28 placeholder for INA4180.....   | <b>9</b>    |
| • Changed Figure 29.....   | <b>9</b>    |
| • Added "(A3 Devices)" to end of Figure 29 title.....  | <b>9</b>    |
| • Added new Figure 38 for INA2180.....   | <b>9</b>    |
| • Changed "less than 150 $\mu$ V" to "within $\pm$ 150 $\mu$ V" regarding offset voltage in <i>Precise Low-Side Current Sensing</i> section..... | <b>18</b>   |
| • Added text regarding RC filter and reference to application report to note at the bottom of Figure 45.....                                     | <b>21</b>   |
| • Deleted $V_S$ from Equation 2 .....  | <b>22</b>   |

- Added equation and curve for  $f_{-3dB}$  to Figure 46.....23
- Added link to reference design TIDA-00302 to end of *Common-Mode Transients Greater Than 26 V* section...  
26
- Added new bullet to *Layout Guidelines* section.....27

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|  |             |
|--|-------------|
| <b>Changes from Revision A (August 2017) to Revision B (November 2017)</b> | <b>Page</b> |
|--|-------------|

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- Added INA4180 preview device and associated content to data sheet..... 1
- Changed design parameter name in Table 3 from "Accuracy" to "Current sensing error" for clarity ..... 25
- Changed "RMS" to "RSS" in reference to equation 7.....25

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|   |             |
|---|-------------|
| <b>Changes from Revision * (April 2017) to Revision A (August 2017)</b> | <b>Page</b> |
|---|-------------|

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- Added INA2180 preview device and associated content to data sheet..... 1
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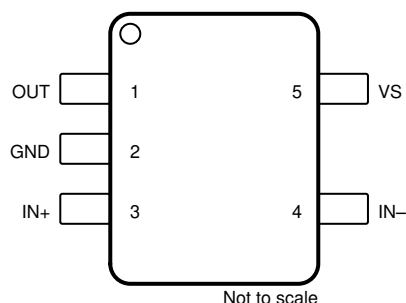
## 5 Device Comparison

**Table 5-1. Device Comparison**

| PRODUCT                 | NUMBER OF CHANNELS | GAIN (V/V) |
|-------------------------|--------------------|------------|
| INA180A1 <sup>(1)</sup> | 1                  | 20         |
| INA180A2 <sup>(1)</sup> | 1                  | 50         |
| INA180A3 <sup>(1)</sup> | 1                  | 100        |
| INA180A4 <sup>(1)</sup> | 1                  | 200        |
| INA180B1 <sup>(1)</sup> | 1                  | 20         |
| INA180B2 <sup>(1)</sup> | 1                  | 50         |
| INA180B3 <sup>(1)</sup> | 1                  | 100        |
| INA180B4 <sup>(1)</sup> | 1                  | 200        |
| INA2180A1               | 2                  | 20         |
| INA2180A2               | 2                  | 50         |
| INA2180A3               | 2                  | 100        |
| INA2180A4               | 2                  | 200        |
| INA4180A1               | 4                  | 20         |
| INA4180A2               | 4                  | 50         |
| INA4180A3               | 4                  | 100        |
| INA4180A4               | 4                  | 200        |

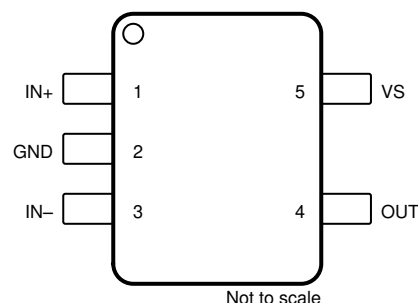
(1) INA180A devices use pinout A. INA180B devices use pinout B. See the [Pin Configuration and Functions](#) section for more information.

## 6 Pin Configuration and Functions



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**Figure 6-1. INA180: DBV Package 5-Pin SOT-23 (Pinout A) Top View**

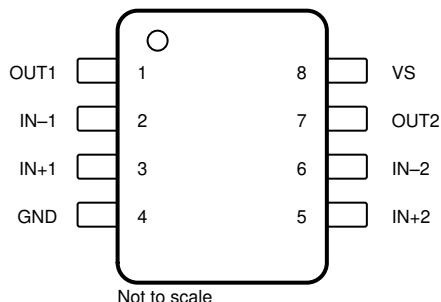


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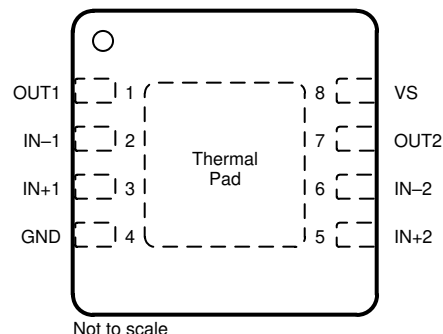
**Figure 6-2. INA180: DBV Package 5-Pin SOT-23 (Pinout B) Top View**

**Table 6-1. Pin Functions: INA180 (Single Channel)**

| NAME | PIN             |                 | TYPE          | DESCRIPTION   |
|------|-----------------|-----------------|---------------|---|
|      | SOT-23 Pinout A | SOT-23 Pinout B |               |   |
| GND  | 2               | 2               | Analog        | Ground  |
| IN–  | 4               | 3               | Analog input  | Current-sense amplifier negative input. For high-side applications, connect to load side of sense resistor. For low-side applications, connect to ground side of sense resistor.      |
| IN+  | 3               | 1               | Analog input  | Current-sense amplifier positive input. For high-side applications, connect to bus-voltage side of sense resistor. For low-side applications, connect to load side of sense resistor. |
| OUT  | 1               | 4               | Analog output | Output voltage  |
| VS   | 5               | 5               | Analog        | Power supply, 2.7 V to 5.5 V  |

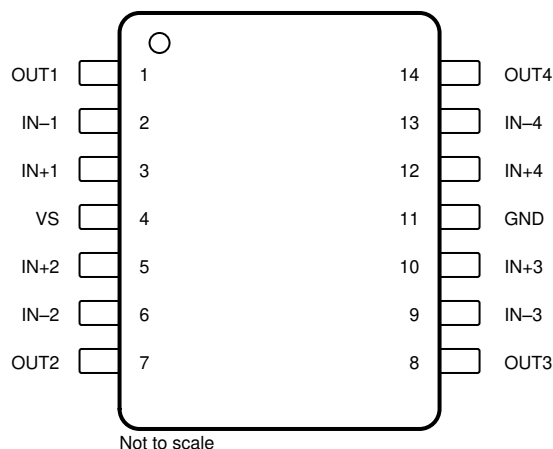


**Figure 6-3. INA2180: DGK Package 8-Pin VSSOP Top View**



A. Thermal Pad can be left floating or connected to GND.

**Figure 6-4. INA2180: DSG Package 8-Pin WSON Top View**



**Figure 6-5. INA4180: PW Package 14-Pin TSSOP Top View**

**Table 6-2. Pin Functions: INA2180 (Dual Channel) and INA4180 (Quad Channel)**

| NAME | PIN     |         | TYPE         | DESCRIPTION   |
|------|---------|---------|--------------|---|
|      | INA2180 | INA4180 |              |   |
| GND  | 4       | 11      | Analog       | Ground  |
| IN-1 | 2       | 2       | Analog input | Current-sense amplifier negative input for channel 1. For high-side applications, connect to load side of channel-1 sense resistor. For low-side applications, connect to ground side of channel-1 sense resistor.      |
| IN+1 | 3       | 3       | Analog input | Current-sense amplifier positive input for channel 1. For high-side applications, connect to bus-voltage side of channel-1 sense resistor. For low-side applications, connect to load side of channel-1 sense resistor. |
| IN-2 | 6       | 6       | Analog input | Current-sense amplifier negative input for channel 2. For high-side applications, connect to load side of channel-2 sense resistor. For low-side applications, connect to ground side of channel-2 sense resistor.      |
| IN+2 | 5       | 5       | Analog input | Current-sense amplifier positive input for channel 2. For high-side applications, connect to bus-voltage side of channel-2 sense resistor. For low-side applications, connect to load side of channel-2 sense resistor. |
| IN-3 | —       | 9       | Analog input | Current-sense amplifier negative input for channel 3. For high-side applications, connect to load side of channel-3 sense resistor. For low-side applications, connect to ground side of channel-3 sense resistor.      |
| IN+3 | —       | 10      | Analog input | Current-sense amplifier positive input for channel 3. For high-side applications, connect to bus-voltage side of channel-3 sense resistor. For low-side applications, connect to load side of channel-3 sense resistor. |
| IN-4 | —       | 13      | Analog input | Current-sense amplifier negative input for channel 4. For high-side applications, connect to load side of channel-4 sense resistor. For low-side applications, connect to ground side of channel-4 sense resistor.      |

**Table 6-2. Pin Functions: INA2180 (Dual Channel) and INA4180 (Quad Channel) (continued)**

| PIN  |         |         | TYPE          | DESCRIPTION   |
|------|---------|---------|---------------|---|
| NAME | INA2180 | INA4180 |               |   |
| IN+4 | —       | 12      | Analog input  | Current-sense amplifier positive input for channel 4. For high-side applications, connect to bus-voltage side of channel-4 sense resistor. For low-side applications, connect to load side of channel-4 sense resistor. |
| OUT1 | 1       | 1       | Analog output | Channel 1 output voltage  |
| OUT2 | 7       | 7       | Analog output | Channel 2 output voltage  |
| OUT3 | —       | 8       | Analog output | Channel 3 output voltage  |
| OUT4 | —       | 14      | Analog output | Channel 4 output voltage  |
| VS   | 8       | 4       | Analog        | Power supply, 2.7 V to 5.5 V  |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|   |                                      | MIN       | MAX         | UNIT |
|---|--------------------------------------|-----------|-------------|------|
| Supply voltage, $V_S$                       |                                      |           | 6           | V    |
| Analog inputs, $IN+$ , $IN-$ <sup>(2)</sup> | Differential ( $V_{IN+} - V_{IN-}$ ) | -26       | 26          | V    |
|   | Common-mode <sup>(3)</sup>           | GND – 0.3 | 26          | V    |
| Output Voltage                              |                                      | GND – 0.3 | $V_S + 0.3$ | V    |
| Maximum output current, $I_{OUT}$           |                                      |           | 8           | mA   |
| Operating free-air temperature, $T_A$       |                                      | -55       | 150         | °C   |
| Junction temperature, $T_J$                 |                                      |           | 150         | °C   |
| Storage temperature, $T_{stg}$              |                                      | -65       | 150         | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2)  $V_{IN+}$  and  $V_{IN-}$  are the voltages at the  $IN+$  and  $IN-$  pins, respectively.

(3) Input voltage at any pin can exceed the voltage shown if the current at that terminal is limited to 5 mA.

### 7.2 ESD Ratings

|             |                         |  | MIN | MAX   | UNIT |
|-------------|-------------------------|--|-----|-------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              |     | ±3000 | V    |
|             |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> |     | ±1000 |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|          |   | MIN  | NOM | MAX | UNIT |
|----------|---|------|-----|-----|------|
| $V_{CM}$ | Common-mode input voltage ( $IN+$ and $IN-$ ) | -0.2 | 12  | 26  | V    |
| $V_S$    | Operating supply voltage                      | 2.7  | 5   | 5.5 | V    |
| $T_A$    | Operating free-air temperature                | -40  |     | 125 | °C   |

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | INA180      | INA2180    |             | INA4180    | UNIT |
|-------------------------------|--|-------------|------------|-------------|------------|------|
|                               |  | DBV (SOT23) | DSG (WSON) | DGK (VSSOP) | PW (TSSOP) |      |
|                               |  | 5 PINS      | 8 PINS     | 8 PINS      | 14 PINS    |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 197.1       | 74.9       | 177.9       | 115.9      | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 95.8        | 90.8       | 65.6        | 44.3       | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 53.1        | 40.8       | 99.3        | 59.2       | °C/W |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 23.4        | 3.7        | 10.5        | 4.7        | °C/W |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 52.7        | 40.8       | 97.9        | 58.6       | °C/W |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | N/A         | 16.8       | N/A         | N/A        | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 7.5 Electrical Characteristics

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ ,  $V_{IN+} = 12\text{ V}$ , and  $V_{SENSE} = V_{IN+} - V_{IN-}$  (unless otherwise noted)

| PARAMETER                           |   | CONDITIONS  | MIN   | TYP                  | MAX                 | UNIT                         |
|-------------------------------------|---|---|---|----------------------|---------------------|------------------------------|
| <b>INPUT</b>                        |   |   |   |                      |                     |                              |
| CMRR                                | Common-mode rejection ratio, RTI <sup>(1)</sup> | $V_{IN+} = 0\text{ V to } 26\text{ V}$ , $V_{SENSE} = 10\text{ mV}$ ,<br>$T_A = -40^\circ\text{C to } +125^\circ\text{C}$ | 84  | 100                  |                     | dB                           |
| $V_{OS}$                            | Offset voltage <sup>(2)</sup> , RTI             | $V_{IN+} = 0\text{ V}$  |   | $\pm 25$             | $\pm 150$           | $\mu\text{V}$                |
|                                     |   |   |   | $\pm 100$            | $\pm 500$           | $\mu\text{V}$                |
| $dV_{OS}/dT$                        | Offset drift, RTI                               | $T_A = -40^\circ\text{C to } +125^\circ\text{C}$  |   | 0.2                  | 1                   | $\mu\text{V}/^\circ\text{C}$ |
| PSRR                                | Power supply rejection ratio, RTI               | $V_S = 2.7\text{ V to } 5.5\text{ V}$ , $V_{SENSE} = 10\text{ mV}$  |   | $\pm 8$              | $\pm 40$            | $\mu\text{V/V}$              |
| $I_{IB}$                            | Input bias current                              | $V_{SENSE} = 0\text{ mV}$ , $V_{IN+} = 0\text{ V}$  |   | 0.1                  |                     | $\mu\text{A}$                |
|                                     |   | $V_{SENSE} = 0\text{ mV}$   |   | 80                   |                     |                              |
| $I_{IO}$                            | Input offset current                            | $V_{SENSE} = 0\text{ mV}$   |   | $\pm 0.05$           |                     | $\mu\text{A}$                |
| <b>OUTPUT</b>                       |   |   |   |                      |                     |                              |
| G                                   | Gain  | A1 devices  |   | 20                   |                     | V/V                          |
|                                     |   | A2 devices  |   | 50                   |                     |                              |
|                                     |   | A3 devices  |   | 100                  |                     |                              |
|                                     |   | A4 devices  |   | 200                  |                     |                              |
| $E_G$                               | Gain error                                      | $V_{OUT} = 0.5\text{ V to } V_S - 0.5\text{ V}$ ,<br>$T_A = -40^\circ\text{C to } +125^\circ\text{C}$                     |   | $\pm 0.1\%$          | $\pm 1\%$           |                              |
|                                     | Gain error vs temperature                       | $T_A = -40^\circ\text{C to } +125^\circ\text{C}$  |   | 1.5                  | 20                  | ppm/ $^\circ\text{C}$        |
|                                     | Nonlinearity error                              | $V_{OUT} = 0.5\text{ V to } V_S - 0.5\text{ V}$   |   | $\pm 0.01\%$         |                     |                              |
|                                     | Maximum capacitive load                         | No sustained oscillation  |   | 1                    |                     | nF                           |
| <b>VOLTAGE OUTPUT<sup>(3)</sup></b> |   |   |   |                      |                     |                              |
| $V_{SP}$                            | Swing to $V_S$ power-supply rail <sup>(4)</sup> | $R_L = 10\text{ k}\Omega$ to GND, $T_A = -40^\circ\text{C to } +125^\circ\text{C}$  |   | $(V_S) - 0.02$       | $(V_S) - 0.03$      | V                            |
| $V_{SN}$                            | Swing to GND <sup>(4)</sup>                     | $R_L = 10\text{ k}\Omega$ to GND, $T_A = -40^\circ\text{C to } +125^\circ\text{C}$  |   | $(V_{GND}) + 0.0005$ | $(V_{GND}) + 0.005$ | V                            |
| <b>FREQUENCY RESPONSE</b>           |   |   |   |                      |                     |                              |
| BW                                  | Bandwidth                                       | A1 devices, $C_{LOAD} = 10\text{ pF}$   |   | 350                  |                     | kHz                          |
|                                     |   | A2 devices, $C_{LOAD} = 10\text{ pF}$   |   | 210                  |                     | kHz                          |
|                                     |   | A3 devices, $C_{LOAD} = 10\text{ pF}$   |   | 150                  |                     | kHz                          |
|                                     |   | A4 devices, $C_{LOAD} = 10\text{ pF}$   |   | 105                  |                     | kHz                          |
| SR                                  | Slew rate                                       |   |   | 2                    |                     | V/ $\mu\text{s}$             |
| <b>NOISE, RTI</b>                   |   |   |   |                      |                     |                              |
|                                     | Voltage noise density                           |   |   | 40                   |                     | nV/ $\sqrt{\text{Hz}}$       |
| <b>POWER SUPPLY</b>                 |   |   |   |                      |                     |                              |
| $I_Q$                               | Quiescent current                               | INA180  | $V_{SENSE} = 10\text{ mV}$  | 197                  | 260                 | $\mu\text{A}$                |
|                                     |   |   | $V_{SENSE} = 10\text{ mV}$ , $T_A = -40^\circ\text{C to } +125^\circ\text{C}$ |                      | 300                 | $\mu\text{A}$                |
|                                     |   | INA2180   | $V_{SENSE} = 10\text{ mV}$  | 355                  | 500                 | $\mu\text{A}$                |
|                                     |   |   | $V_{SENSE} = 10\text{ mV}$ , $T_A = -40^\circ\text{C to } +125^\circ\text{C}$ |                      | 520                 | $\mu\text{A}$                |
|                                     |   | INA4180   | $V_{SENSE} = 10\text{ mV}$  | 690                  | 900                 | $\mu\text{A}$                |
|                                     |   |   | $V_{SENSE} = 10\text{ mV}$ , $T_A = -40^\circ\text{C to } +125^\circ\text{C}$ |                      | 1000                | $\mu\text{A}$                |

(1) RTI = referred-to-input.

(2) Offset voltage is obtained by linear extrapolation to  $V_{SENSE} = 0\text{ V}$  with  $V_{SENSE} = 10\%$  to  $90\%$  of full-scale-range.

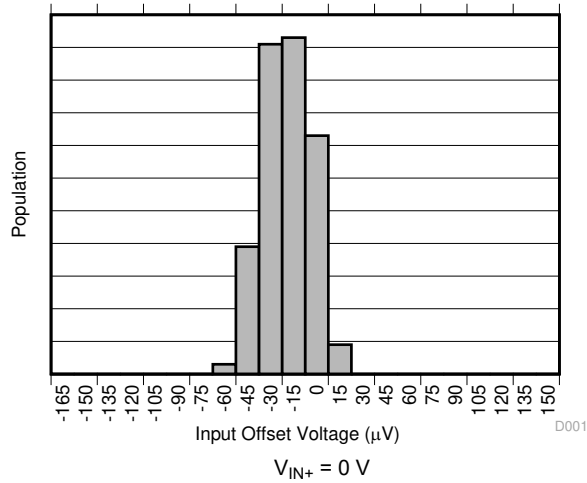
(3) See Figure 7-19.

(4) Swing specifications are tested with an overdriven input condition.

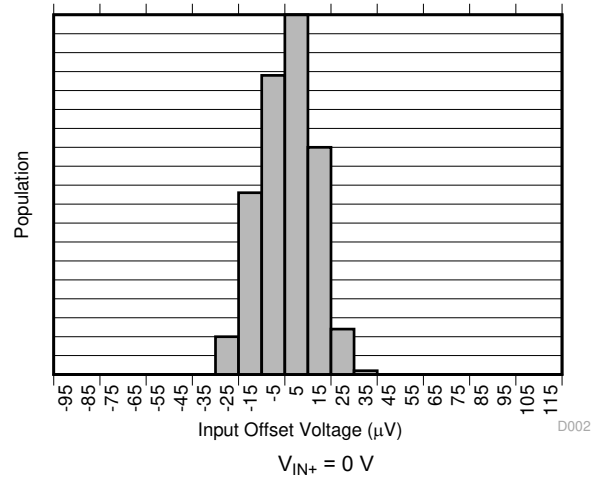


## 7.6 Typical Characteristics

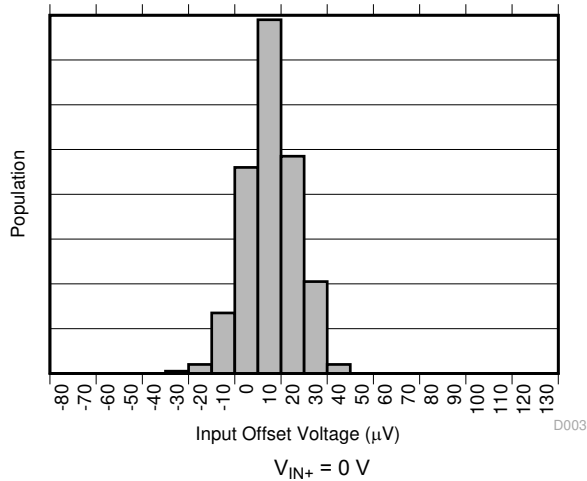
at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ , and  $V_{IN+} = 12\text{ V}$  (unless otherwise noted)



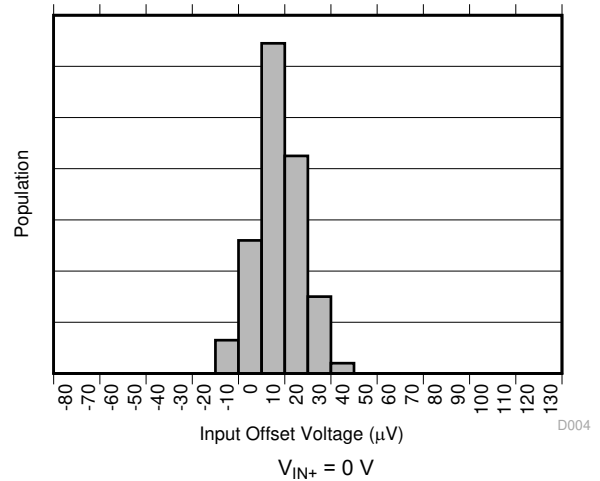
**Figure 7-1. Input Offset Voltage Production Distribution A1**



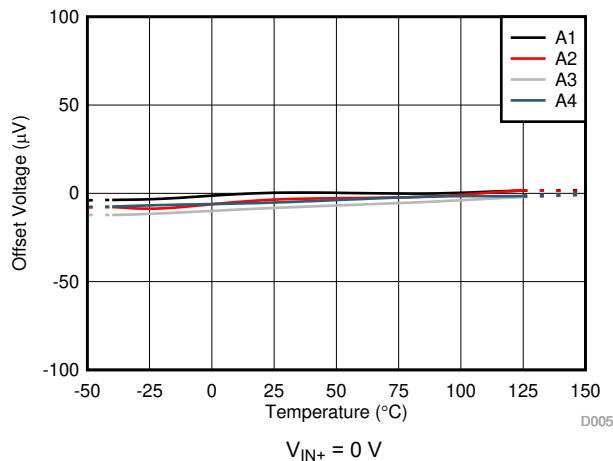
**Figure 7-2. Input Offset Voltage Production Distribution A2**



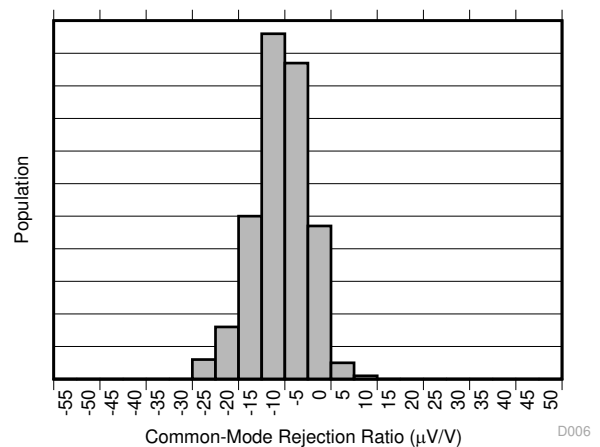
**Figure 7-3. Input Offset Voltage Production Distribution A3**



**Figure 7-4. Input Offset Voltage Production Distribution A4**



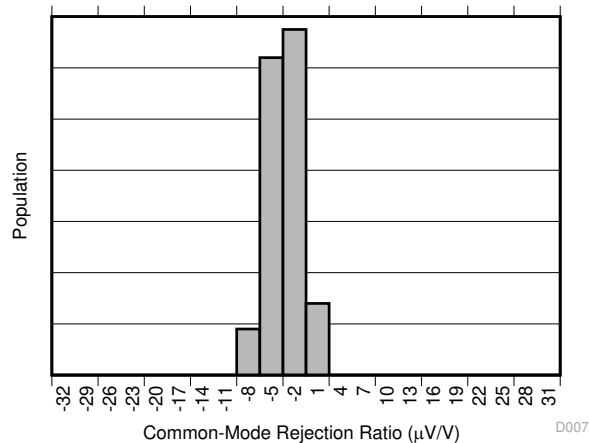
**Figure 7-5. Offset Voltage vs. Temperature**



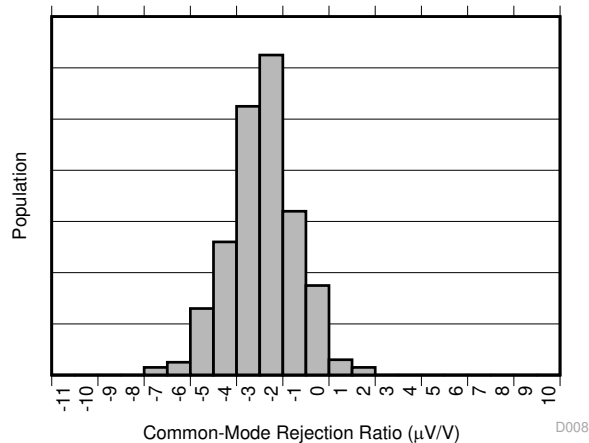
**Figure 7-6. Common-Mode Rejection Production Distribution A1**

## 7.6 Typical Characteristics (continued)

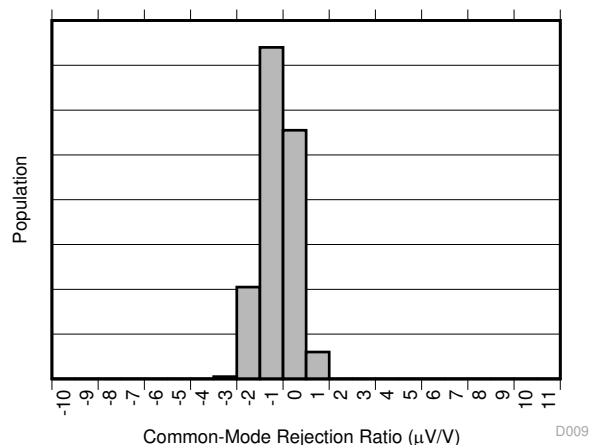
at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ , and  $V_{IN+} = 12\text{ V}$  (unless otherwise noted)



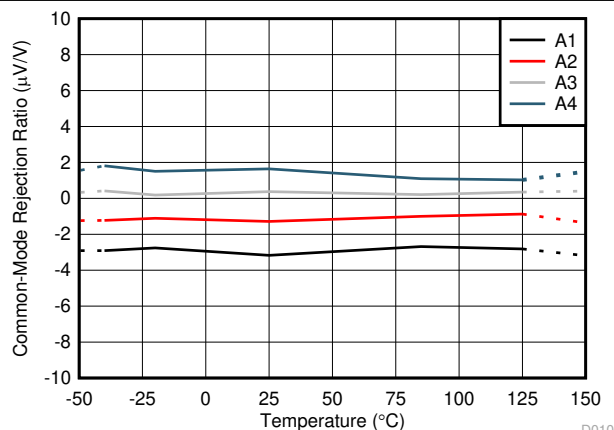
**Figure 7-7. Common-Mode Rejection Production Distribution A2**



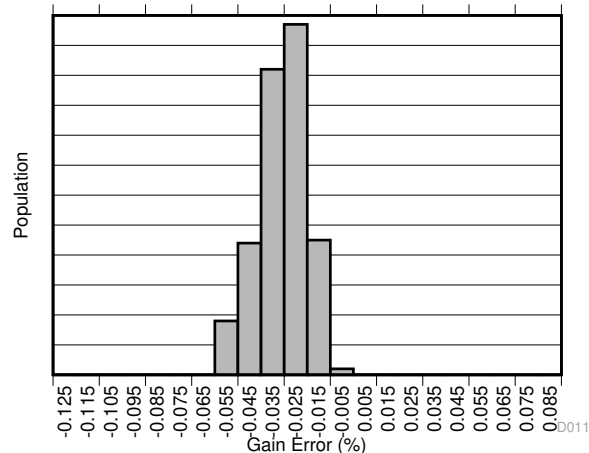
**Figure 7-8. Common-Mode Rejection Production Distribution A3**



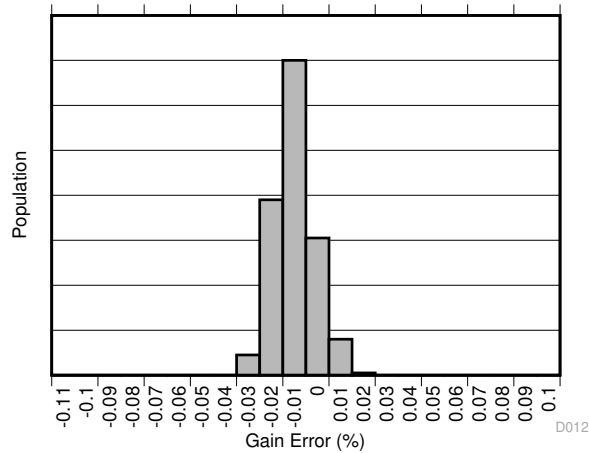
**Figure 7-9. Common-Mode Rejection Production Distribution A4**



**Figure 7-10. Common-Mode Rejection Ratio vs. Temperature**



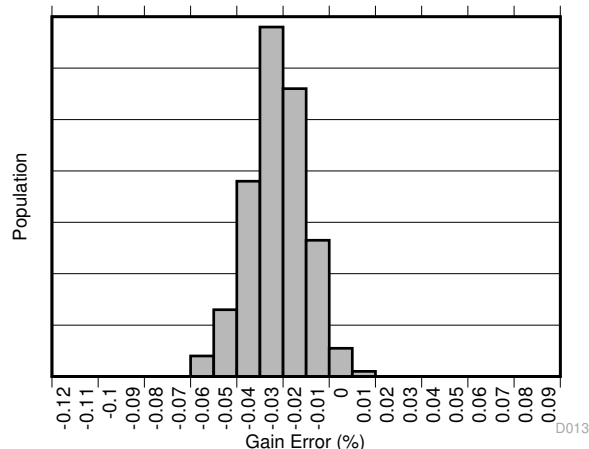
**Figure 7-11. Gain Error Production Distribution A1**



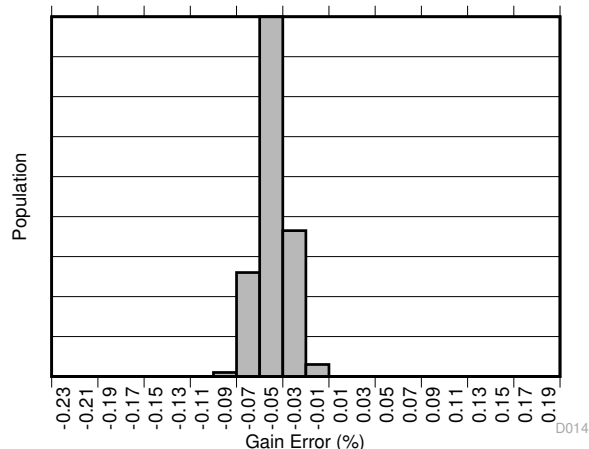
**Figure 7-12. Gain Error Production Distribution A2**

## 7.6 Typical Characteristics (continued)

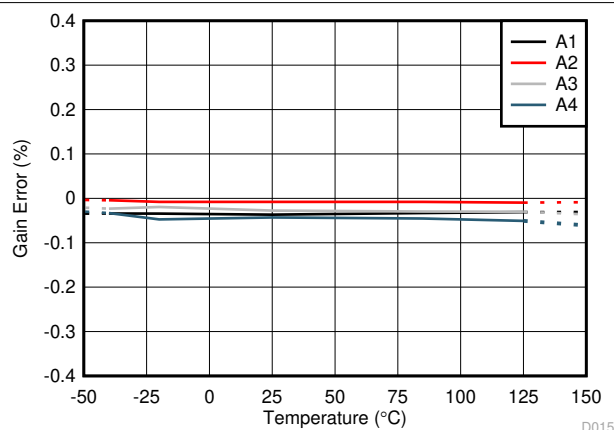
at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ , and  $V_{IN+} = 12\text{ V}$  (unless otherwise noted)



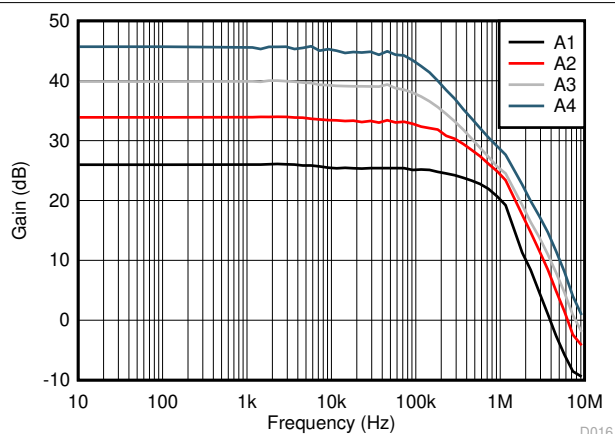
**Figure 7-13. Gain Error Production Distribution A3**



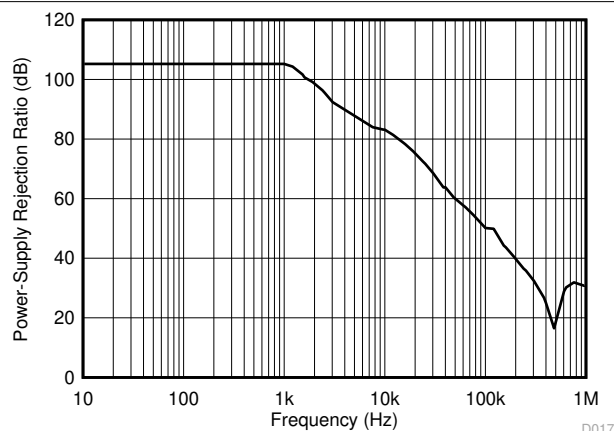
**Figure 7-14. Gain Error Production Distribution A4**



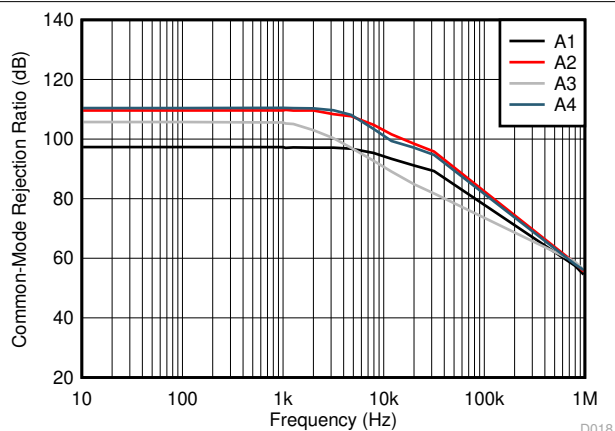
**Figure 7-15. Gain Error vs. Temperature**



**Figure 7-16. Gain vs. Frequency**



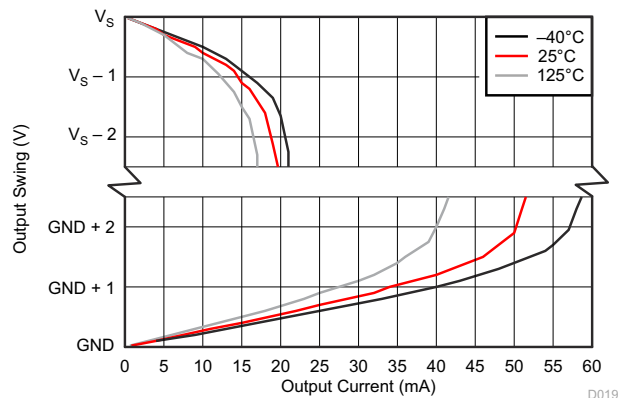
**Figure 7-17. Power-Supply Rejection Ratio vs. Frequency**



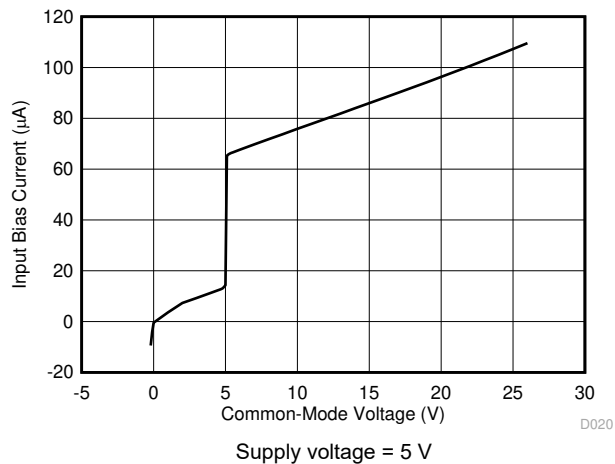
**Figure 7-18. Common-Mode Rejection Ratio vs. Frequency**

## 7.6 Typical Characteristics (continued)

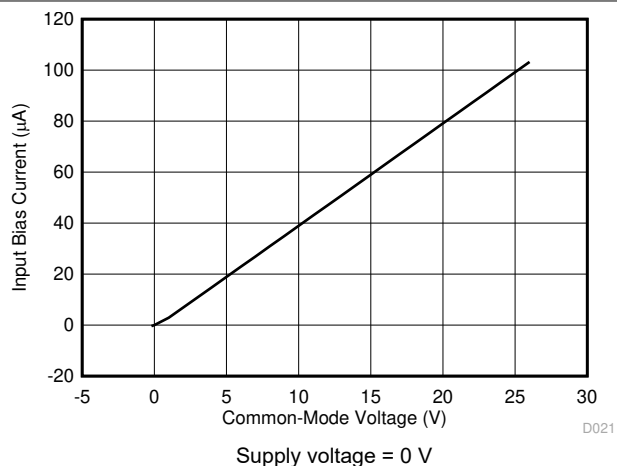
at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ , and  $V_{IN+} = 12\text{ V}$  (unless otherwise noted)



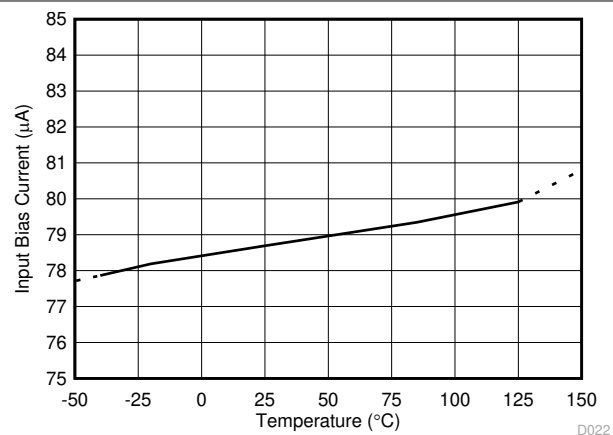
**Figure 7-19. Output Voltage Swing vs. Output Current**



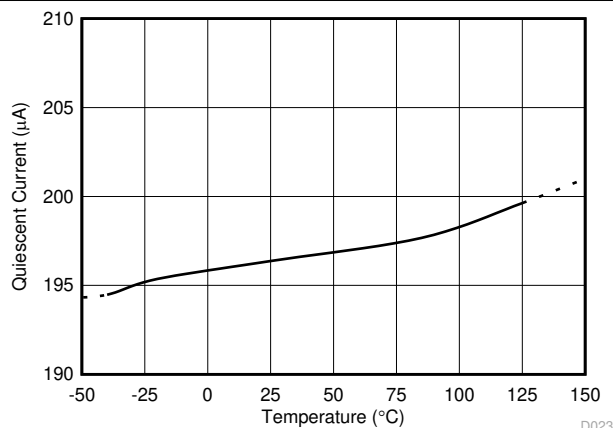
**Figure 7-20. Input Bias Current vs. Common-Mode Voltage**



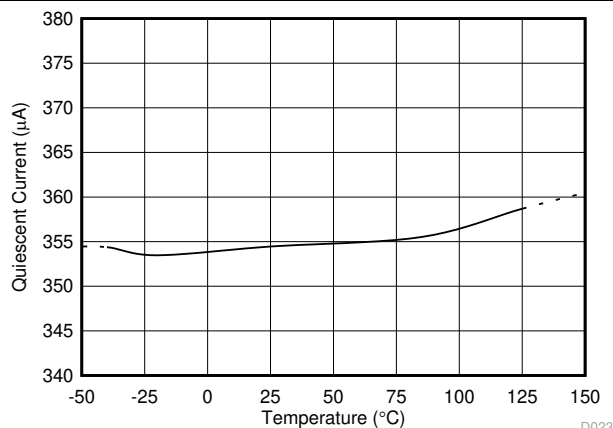
**Figure 7-21. Input Bias Current vs. Common-Mode Voltage (Both Inputs, Shutdown)**



**Figure 7-22. Input Bias Current vs. Temperature**



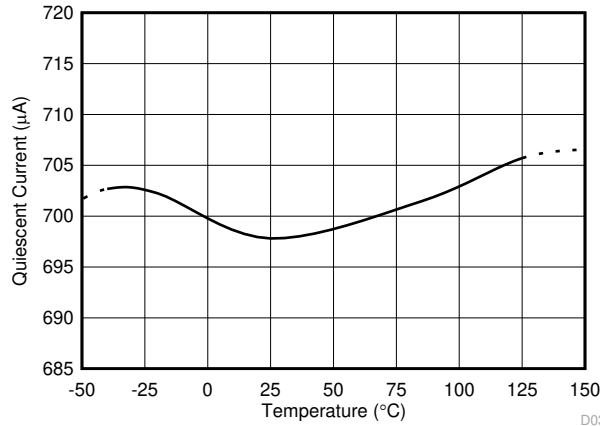
**Figure 7-23. Quiescent Current vs. Temperature (INA180)**



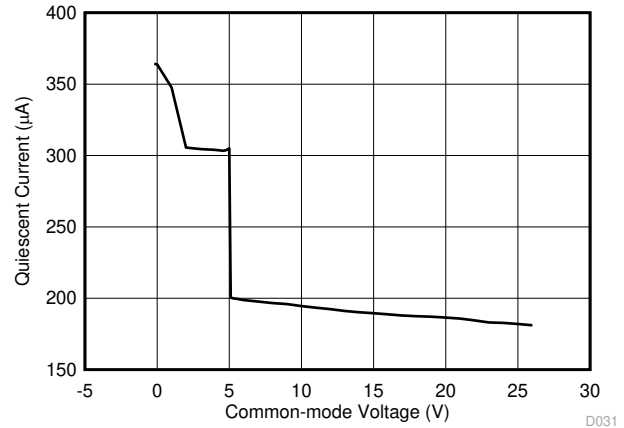
**Figure 7-24. Quiescent Current vs. Temperature (INA2180)**

## 7.6 Typical Characteristics (continued)

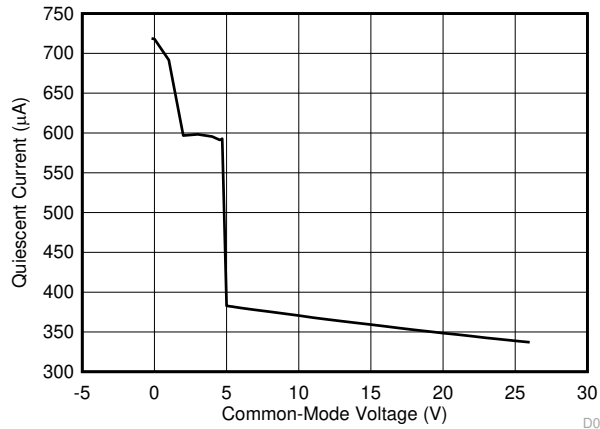
at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ , and  $V_{IN+} = 12\text{ V}$  (unless otherwise noted)



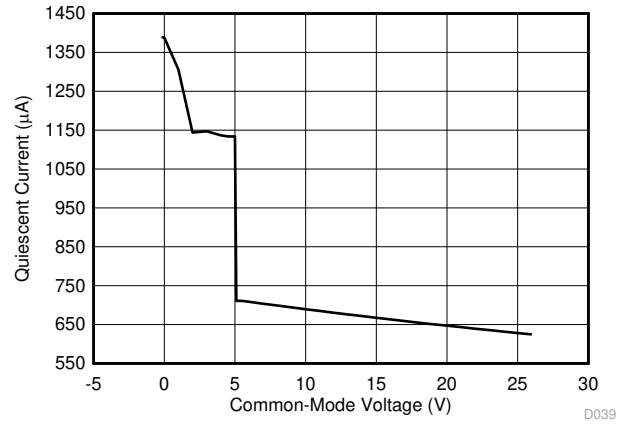
**Figure 7-25. Quiescent Current vs. Temperature (INA4180)**



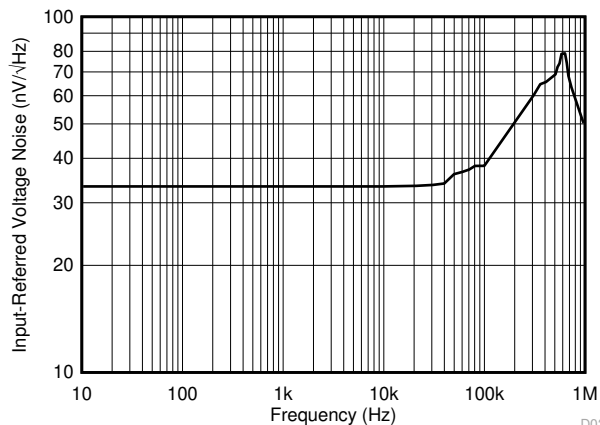
**Figure 7-26. Quiescent Current vs. Common-Mode Voltage (INA180)**



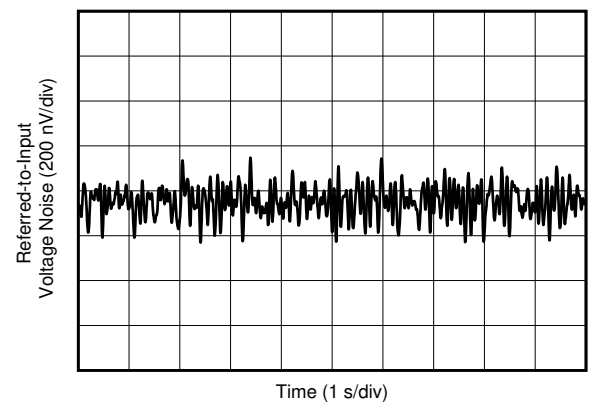
**Figure 7-27. Quiescent Current vs. Common-Mode Voltage for All Amplifiers (INA2180)**



**Figure 7-28. Quiescent Current vs. Common-Mode Voltage for All Amplifiers (INA4180)**



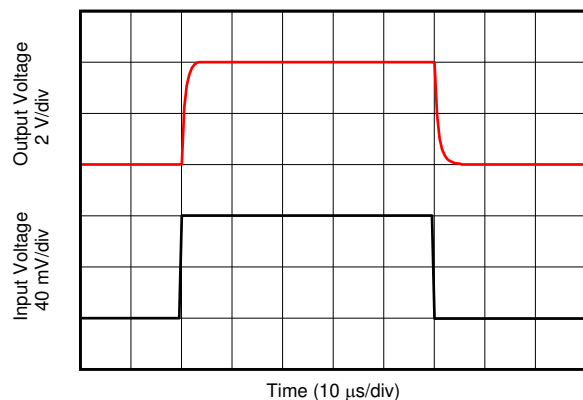
**Figure 7-29. Input-Referred Voltage Noise vs. Frequency (A3 Devices)**



**Figure 7-30. 0.1-Hz to 10-Hz Voltage Noise (Referred-to-Input)**

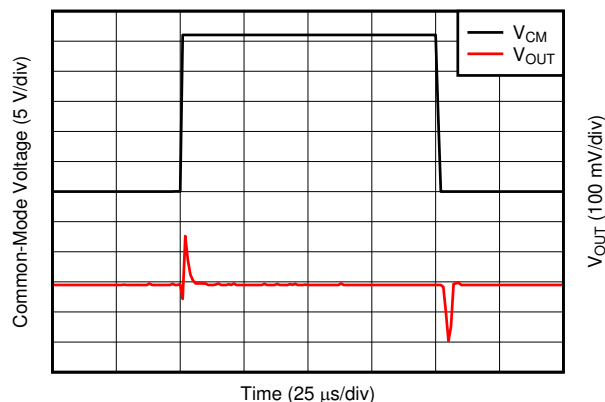
## 7.6 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ , and  $V_{IN+} = 12\text{ V}$  (unless otherwise noted)



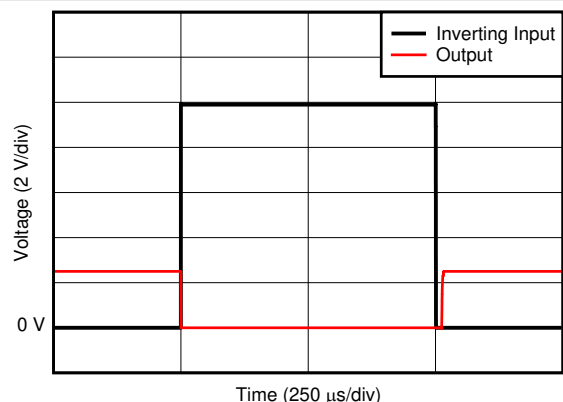
80-mV<sub>PP</sub> input step  
**Figure 7-31. Step Response**

D026



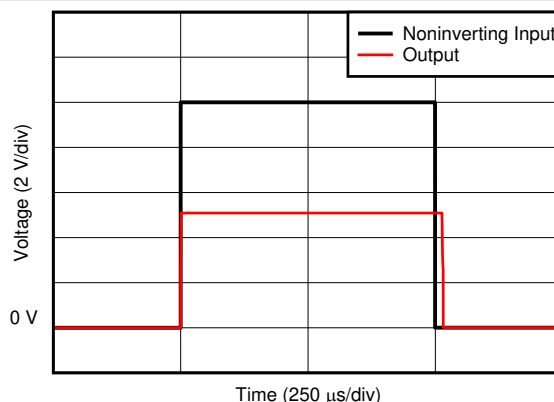
**Figure 7-32. Common-Mode Voltage Transient Response**

D027



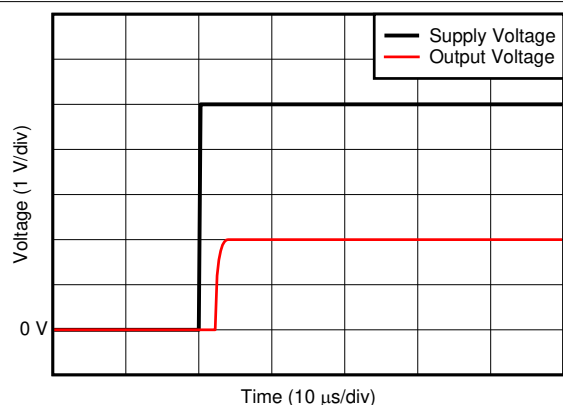
**Figure 7-33. Inverting Differential Input Overload**

D028



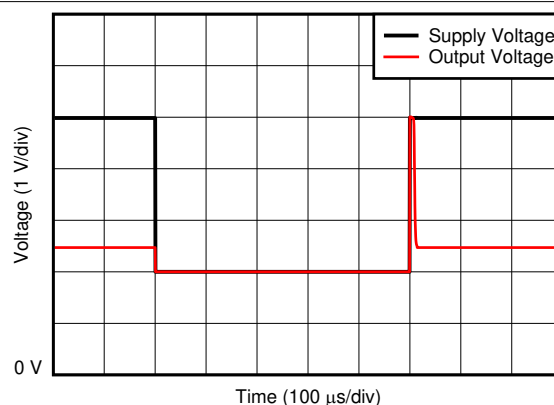
**Figure 7-34. Noninverting Differential Input Overload**

D029



**Figure 7-35. Start-Up Response**

D030

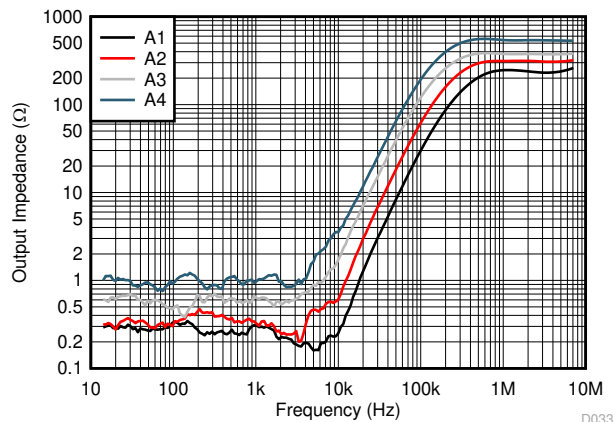


**Figure 7-36. Brownout Recovery**

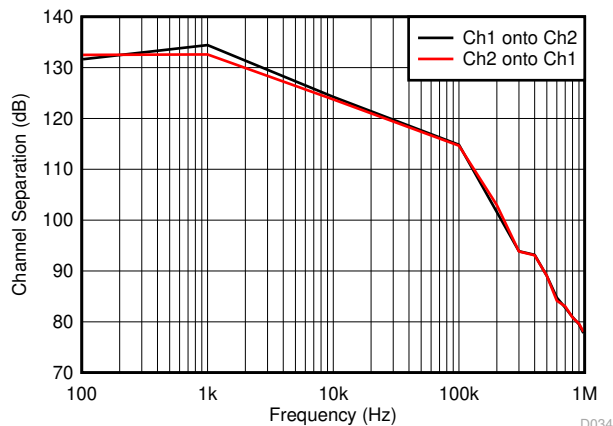
D032

## 7.6 Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 5\text{ V}$ , and  $V_{IN+} = 12\text{ V}$  (unless otherwise noted)



**Figure 7-37. Output Impedance vs. Frequency**



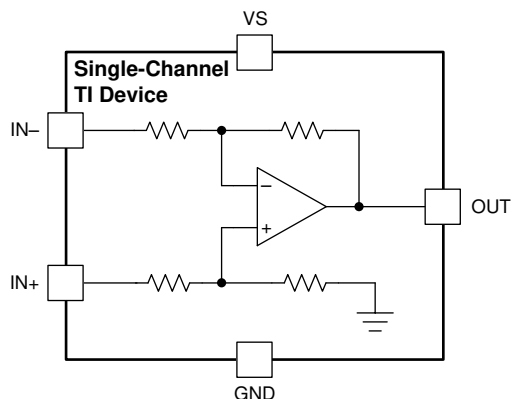
**Figure 7-38. Channel Separation vs. Frequency (INA2180)**

## 8 Detailed Description

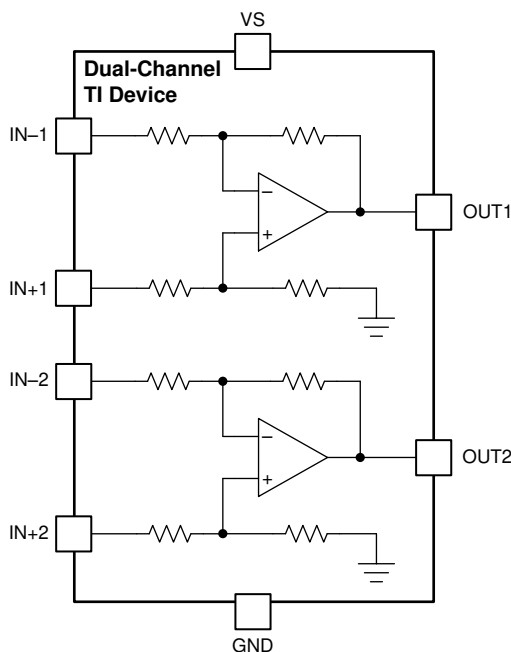
### 8.1 Overview

The INA180, INA2180, and INA4180 (INAx180) are 26-V, common-mode, current-sensing amplifiers used in both low-side and high-side configurations. These specially-designed, current-sensing amplifiers accurately measures voltages developed across current-sensing resistors on common-mode voltages that far exceed the supply voltage powering the device. Current can be measured on input voltage rails as high as 26 V, and the devices can be powered from supply voltages as low as 2.7 V.

### 8.2 Functional Block Diagrams

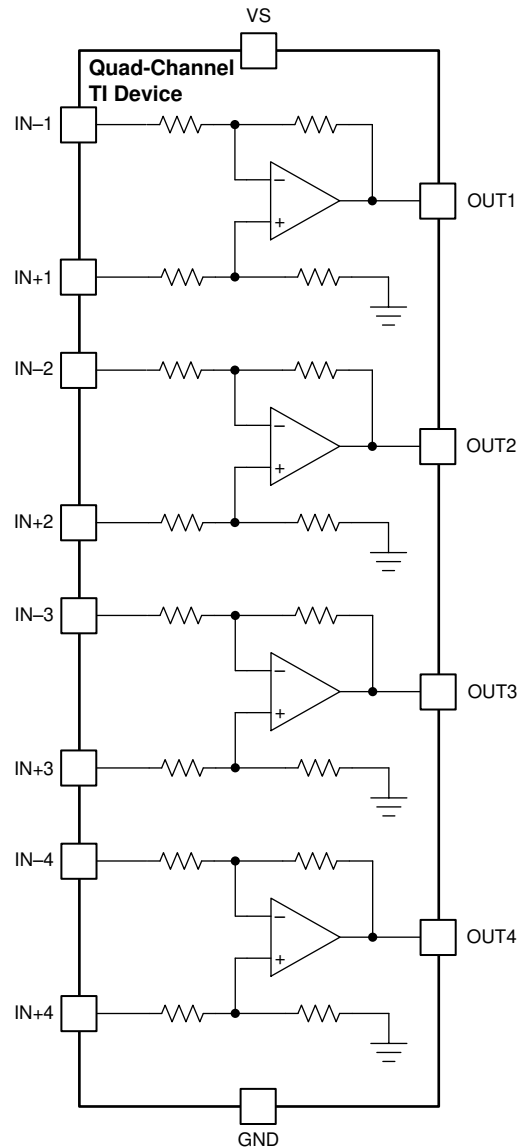


**Figure 8-1. INA180 Functional Block Diagram**



**Figure 8-2. INA2180 Functional Block Diagram**





**Figure 8-3. INA4180 Functional Block Diagram**

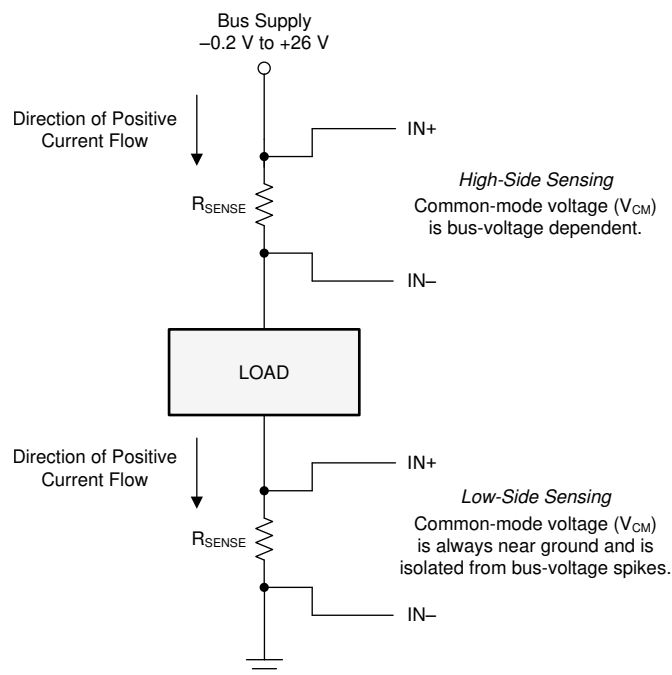
## 8.3 Feature Description

### 8.3.1 High Bandwidth and Slew Rate

The INAx180 support small-signal bandwidths as high as 350 kHz, and large-signal slew rates of 2 V/ $\mu$ s. The ability to detect rapid changes in the sensed current, as well as the ability to quickly slew the output, make the INAx180 a good choice for applications that require a quick response to input current changes. One application that requires high bandwidth and slew rate is low-side motor control, where the ability to follow rapid changing current in the motor allows for more accurate control over a wider operating range. Another application that requires higher bandwidth and slew rates is system fault detection, where the INAx180 are used with an external comparator and a reference to quickly detect when the sensed current is out of range.

### 8.3.2 Wide Input Common-Mode Voltage Range

The INAx180 support input common-mode voltages from  $-0.2$  V to  $+26$  V. Because of the internal topology, the common-mode range is not restricted by the power-supply voltage ( $V_S$ ) as long as  $V_S$  stays within the operational range of 2.7 V to 5.5 V. The ability to operate with common-mode voltages greater or less than  $V_S$  allow the INAx180 to be used in high-side, as well as low-side, current-sensing applications, as shown in Figure 8-4.



**Figure 8-4. High-Side and Low-Side Sensing Connections**

### 8.3.3 Precise Low-Side Current Sensing

When used in low-side current sensing applications the offset voltage of the INAx180 is within  $\pm 150$   $\mu$ V. The low offset performance of the INAx180 has several benefits. First, the low offset allows the device to be used in applications that must measure current over a wide dynamic range. In this case, the low offset improves the accuracy when the sensed currents are on the low end of the measurement range. Another advantage of low offset is the ability to sense lower voltage drop across the sense resistor accurately, thus allowing a lower-value shunt resistor. Lower-value shunt resistors reduce power loss in the current sense circuit, and help improve the power efficiency of the end application.

The gain error of the INAx180 is specified to be within 1% of the actual value. As the sensed voltage becomes much larger than the offset voltage, this voltage becomes the dominant source of error in the current sense measurement.

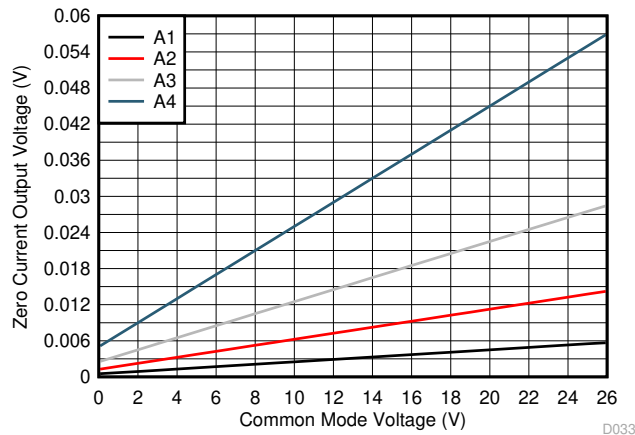
### 8.3.4 Rail-to-Rail Output Swing

The INAx180 allow linear current sensing operation with the output close to the supply rail and GND. The maximum specified output swing to the positive rail is 30 mV, and the maximum specified output swing to GND is only 5 mV. To compare the output swing of the INAx180 to an equivalent operational amplifier (op amp), the inputs are overdriven to approximate the open-loop condition specified in op amp data sheets. The current-sense amplifier is a closed-loop system; therefore, the output swing to GND can be limited by the product of the offset voltage and amplifier gain.

For devices that have positive offset voltages, the swing to GND is limited by the larger of either the offset voltage multiplied by the gain or the swing to GND specified in the [Electrical Characteristics](#) table.

For example, in an application where the INA180A4 (gain = 200 V/V) is used for low-side current sensing and the device has an offset of 40  $\mu$ V, the product of the device offset and gain results in a value of 8 mV, greater than the specified negative swing value. Therefore, the swing to GND for this example is 8 mV. If the same device has an offset of  $-40$   $\mu$ V, then the calculated zero differential signal is  $-8$  mV. In this case, the offset helps overdrive the swing in the negative direction, and swing performance is consistent with the value specified in the [Electrical Characteristics](#) table.

The offset voltage is a function of the common-mode voltage as determined by the CMRR specification; therefore, the offset voltage increases when higher common-mode voltages are present. The increase in offset voltage limits how low the output voltage can go during a zero-current condition when operating at higher common-mode voltages. [Figure 8-5](#) shows the typical limitation of the zero-current output voltage vs common-mode voltage for each gain option.



**Figure 8-5. Zero-Current Output Voltage vs Common-Mode Voltage**

## 8.4 Device Functional Modes

### 8.4.1 Normal Mode

The INAx180 is in normal operation when the following conditions are met:

- The power supply voltage ( $V_S$ ) is between 2.7 V and 5.5 V.
- The common-mode voltage ( $V_{CM}$ ) is within the specified range of  $-0.2$  V to +26 V.
- The maximum differential input signal times gain is less than  $V_S$  minus the output voltage swing to  $V_S$ .
- The minimum differential input signal times gain is greater than the swing to GND (see the [Rail-to-Rail Output Swing](#) section).

During normal operation, the device produces an output voltage that is the *gained-up* representation of the difference voltage from  $IN+$  to  $IN-$ .

### 8.4.2 Input Differential Overload

If the differential input voltage ( $V_{IN+} - V_{IN-}$ ) times gain exceeds the voltage swing specification, the INAx180 drive the output as close as possible to the positive supply, and does not provide accurate measurement of the differential input voltage. If this input overload occurs during normal circuit operation, then reduce the value of

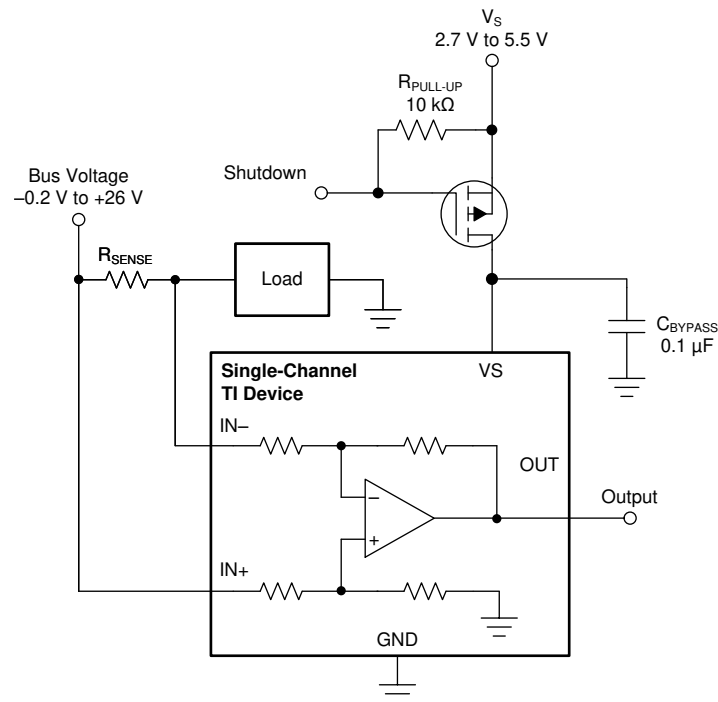
the shunt resistor or use a lower-gain version with the chosen sense resistor to avoid this mode of operation. If a differential overload occurs in a fault event, then the output of the INAx180 return to the expected value approximately 20  $\mu$ s after the fault condition is removed.

When the INAx180 output is driven to either the supply rail or ground, increasing the differential input voltage does not damage the device as long as the absolute maximum ratings are not violated. Following these guidelines, the INAx180 output maintains polarity, and does not suffer from phase reversal.

### 8.4.3 Shutdown Mode

Although the INAx180 do not have a shutdown pin, the low power consumption of the device allows the output of a logic gate or transistor switch to power the INAx180. This gate or switch turns on and off the INAx180 power-supply quiescent current.

However, in current shunt monitoring applications, there is also a concern for how much current is drained from the shunt circuit in shutdown conditions. Evaluating this current drain involves considering the simplified schematic of the INAx180 in shutdown mode, as shown in Figure 8-6.



**Figure 8-6. Basic Circuit to Shut Down the INx180**

There is typically more than 500 k $\Omega$  of impedance (from the combination of 500-k $\Omega$  feedback and input gain set resistors) from each input of the INAx180 to the OUT pin and to the GND pin. The amount of current flowing through these pins depends on the voltage at the connection.

Regarding the 500-k $\Omega$  path to the output pin, the output stage of a disabled INAx180 does constitute a good path to ground. Consequently, this current is directly proportional to a shunt common-mode voltage present across a 500-k $\Omega$  resistor.

As a final note, as long as the shunt common-mode voltage is greater than  $V_S$  when the device is powered up, there is an additional and well-matched 55- $\mu$ A typical current that flows in each of the inputs. If less than  $V_S$ , the common-mode input currents are negligible, and the only current effects are the result of the 500-k $\Omega$  resistors.

## 9 Application and Implementation

### Note

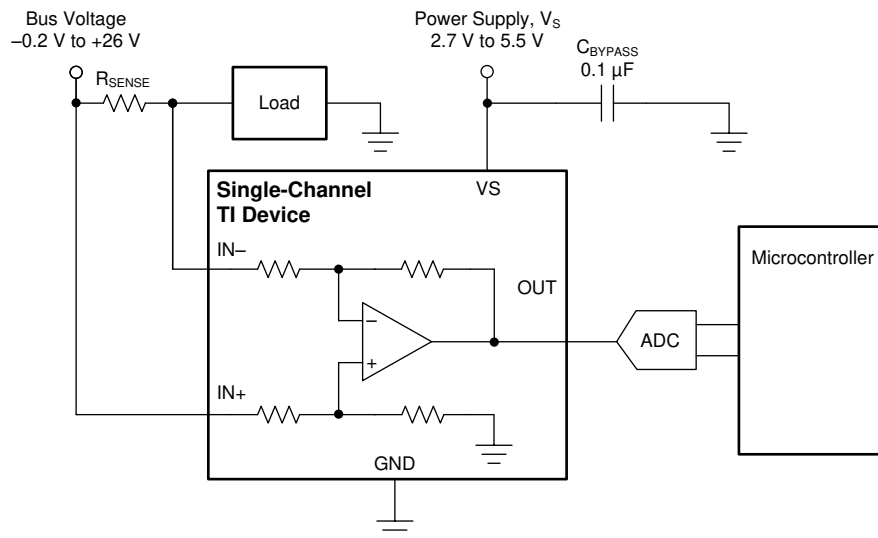
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

The INAx180 amplify the voltage developed across a current-sensing resistor as current flows through the resistor to the load or ground.

#### 9.1.1 Basic Connections

Figure 9-1 shows the basic connections of the INA180. Connect the input pins (IN+ and IN–) as closely as possible to the shunt resistor to minimize any resistance in series with the shunt resistor.



NOTE: For best measurement accuracy, connect analog-to-digital converter (ADC) reference or microcontroller ground as closely as possible to the INAx180 GND pin, and add an RC filter between the output of the INAx180 and the ADC. See [Closed-Loop Analysis of Load-Induced Amplifier Stability Issues Using Z<sub>OUT</sub>](#) for more details.

**Figure 9-1. Basic Connections for the INA180**

A power-supply bypass capacitor of at least 0.1 μF is required for proper operation. Applications with noisy or high-impedance power supplies may require additional decoupling capacitors to reject power-supply noise. Connect bypass capacitors close to the device pins.

### 9.1.2 R<sub>SENSE</sub> and Device Gain Selection

The accuracy of the INAx180 is maximized by choosing the current-sense resistor to be as large as possible. A large sense resistor maximizes the differential input signal for a given amount of current flow and reduces the error contribution of the offset voltage. However, there are practical limits as to how large the current-sense resistor can be in a given application. The INAx180 have a typical input bias currents of 80  $\mu$ A for each input when operated at a 12-V common-mode voltage input. When large current-sense resistors are used, these bias currents cause increased offset error and reduced common-mode rejection. Therefore, using current-sense resistors larger than a few ohms is generally not recommended for applications that require current-monitoring accuracy. A second common restriction on the value of the current-sense resistor is the maximum allowable power dissipation that is budgeted for the resistor. Equation 1 gives the maximum value for the current sense resistor for a given power dissipation budget:

$$R_{SENSE} < \frac{PD_{MAX}}{I_{MAX}^2} \quad (1)$$

where:

- $PD_{MAX}$  is the maximum allowable power dissipation in  $R_{SENSE}$ .
- $I_{MAX}$  is the maximum current that will flow through  $R_{SENSE}$ .

An additional limitation on the size of the current-sense resistor and device gain is due to the power-supply voltage,  $V_S$ , and device swing to rail limitations. In order to make sure that the current-sense signal is properly passed to the output, both positive and negative output swing limitations must be examined. Equation 2 provides the maximum values of  $R_{SENSE}$  and GAIN to keep the device from hitting the positive swing limitation.

$$I_{MAX} \times R_{SENSE} \times GAIN < V_{SP} \quad (2)$$

where:

- $I_{MAX}$  is the maximum current that will flow through  $R_{SENSE}$ .
- GAIN is the gain of the current sense-amplifier.
- $V_{SP}$  is the positive output swing as specified in the data sheet.

To avoid positive output swing limitations when selecting the value of  $R_{SENSE}$ , there is always a trade-off between the value of the sense resistor and the gain of the device under consideration. If the sense resistor selected for the maximum power dissipation is too large, then it is possible to select a lower-gain device in order to avoid positive swing limitations.

The negative swing limitation places a limit on how small of a sense resistor can be used in a given application. Equation 3 provides the limit on the minimum size of the sense resistor.

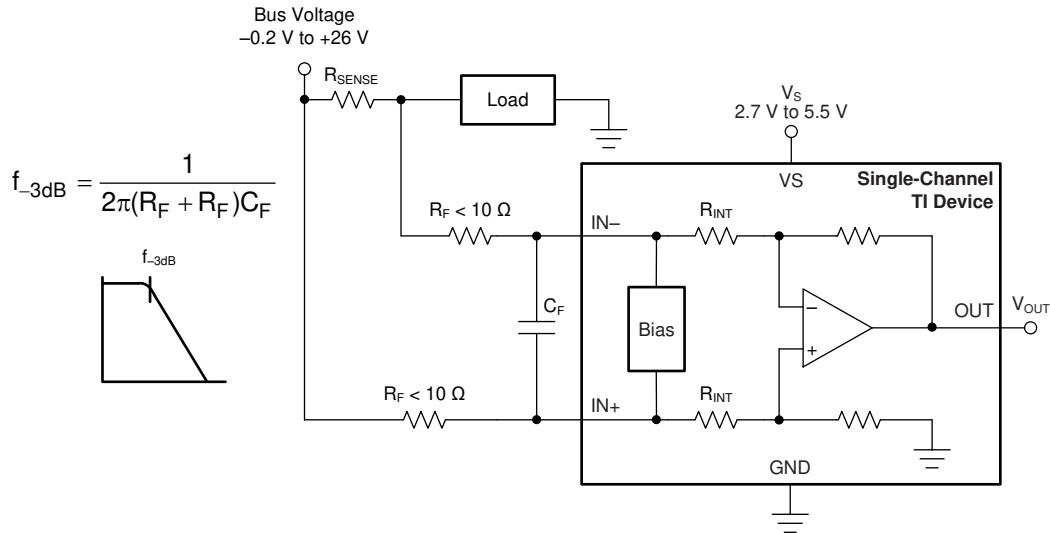
$$I_{MIN} \times R_{SENSE} \times GAIN > V_{SN} \quad (3)$$

where:

- $I_{MIN}$  is the minimum current that will flow through  $R_{SENSE}$ .
- GAIN is the gain of the current sense amplifier.
- $V_{SN}$  is the negative output swing of the device (see [Rail-to-Rail Output Swing](#)).

### 9.1.3 Signal Filtering

Provided that the INAx180 output is connected to a high impedance input, the best location to filter is at the device output using a simple RC network from OUT to GND. Filtering at the output attenuates high-frequency disturbances in the common-mode voltage, differential input signal, and INAx180 power-supply voltage. If filtering at the output is not possible, or filtering of only the differential input signal is required, it is possible to apply a filter at the input pins of the device. [Figure 9-2](#) provides an example of how a filter can be used on the input pins of the device.



**Figure 9-2. Filter at Input Pins**

The addition of external series resistance creates an additional error in the measurement; therefore, the value of these series resistors must be kept to 10 Ω (or less, if possible) to reduce impact to accuracy. The internal bias network shown in [Figure 9-2](#) present at the input pins creates a mismatch in input bias currents when a differential voltage is applied between the input pins. If additional external series filter resistors are added to the circuit, the mismatch in bias currents results in a mismatch of voltage drops across the filter resistors. This mismatch creates a differential error voltage that subtracts from the voltage developed across the shunt resistor. This error results in a voltage at the device input pins that is different than the voltage developed across the shunt resistor. Without the additional series resistance, the mismatch in input bias currents has little effect on device operation. The amount of error these external filter resistors add to the measurement can be calculated using [Equation 5](#), where the gain error factor is calculated using [Equation 4](#).

The amount of variance in the differential voltage present at the device input relative to the voltage developed at the shunt resistor is based both on the external series resistance ( $R_F$ ) value as well as internal input resistor  $R_{INT}$ , as shown in [Figure 9-2](#). The reduction of the shunt voltage reaching the device input pins appears as a gain error when comparing the output voltage relative to the voltage across the shunt resistor. A factor can be calculated to determine the amount of gain error that is introduced by the addition of external series resistance. Calculate the expected deviation from the shunt voltage to what is measured at the device input pins is given using [Equation 4](#):

$$\text{Gain Error Factor} = \frac{1250 \times R_{INT}}{(1250 \times R_F) + (1250 \times R_{INT}) + (R_F \times R_{INT})} \quad (4)$$

where:

- $R_{INT}$  is the internal input resistor.
- $R_F$  is the external series resistance.

With the adjustment factor from [Equation 4](#), including the device internal input resistance, this factor varies with each gain version, as shown in [Table 9-1](#). Each individual device gain error factor is shown in [Table 9-2](#).

**Table 9-1. Input Resistance**

| PRODUCT   | GAIN | R <sub>INT</sub> (kΩ) |
|-----------|------|-----------------------|
| INAx180A1 | 20   | 25                    |
| INAx180A2 | 50   | 10                    |
| INAx180A3 | 100  | 5                     |
| INAx180A4 | 200  | 2.5                   |

**Table 9-2. Device Gain Error Factor**

| PRODUCT   | SIMPLIFIED GAIN ERROR FACTOR            |
|-----------|---|
| INAx180A1 | $\frac{25000}{(21 \times R_F) + 25000}$ |
| INAx180A2 | $\frac{10000}{(9 \times R_F) + 10000}$  |
| INAx180A3 | $\frac{1000}{R_F + 1000}$               |
| INAx180A4 | $\frac{2500}{(3 \times R_F) + 2500}$    |

The gain error that can be expected from the addition of the external series resistors can then be calculated based on [Equation 5](#):

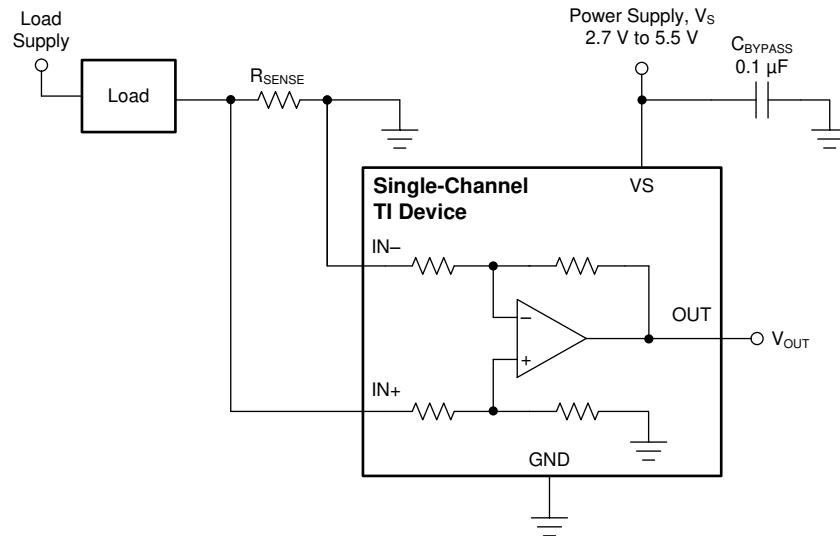
$$\text{Gain Error (\%)} = 100 - (100 \times \text{Gain Error Factor}) \quad (5)$$

For example, using an INA180A2 and the corresponding gain error equation from [Table 9-2](#), a series resistance of

10 Ω results in a gain error factor of 0.991. The corresponding gain error is then calculated using [Equation 5](#), resulting in an additional gain error of approximately 0.89% solely because of the external 10-Ω series resistors.



## 9.2 Typical Application



**Figure 9-3. Low-Side Sensing**

### 9.2.1 Design Requirements

The design requirements for the circuit shown in [Figure 9-3](#), are listed in [Table 9-3](#)

**Table 9-3. Design Parameters**

| DESIGN PARAMETER                 | EXAMPLE VALUE   |
|----------------------------------|---|
| Power-supply voltage, $V_S$      | 5 V   |
| Low-side current sensing         | $V_{CM} = 0$ V  |
| $R_{SENSE}$ power loss           | < 900 mW  |
| Maximum sense current, $I_{MAX}$ | 40 A  |
| Current sensing error            | Less than 1.5% at maximum current, $T_J = 25^\circ\text{C}$ |
| Small-signal bandwidth           | > 80 kHz  |

### 9.2.2 Detailed Design Procedure

The maximum value of the current sense resistor is calculated based on the maximum power loss requirement. By applying [Equation 1](#), the maximum value of the current-sense resistor is calculated to be 0.563 mΩ. This is the maximum value for sense resistor  $R_{SENSE}$ ; therefore, select  $R_{SENSE}$  to be 0.5 mΩ because it is the closest standard resistor value that meets the power-loss requirement.

The next step is to select the appropriate gain and reduce  $R_{SENSE}$ , if needed, to keep the output signal swing within the  $V_S$  range. Using [Equation 2](#), and given that  $I_{MAX} = 40$  A and  $R_{SENSE} = 0.5$  mΩ, the maximum current-sense gain calculated to avoid the positive swing-to-rail limitations on the output is 248.5. To maximize the output signal range, the INA180A4 (gain = 200) device is selected for this application.

To calculate the accuracy at peak current, the two factors that must be determined are the gain error and the offset error. The gain error of the INAx180 is specified to be a maximum of 1%. The error due to the offset is constant, and is specified to be 125 μV (maximum) for the conditions where  $V_{CM} = 0$  V and  $V_S = 5$  V. Using [Equation 6](#), the percentage error contribution of the offset voltage is calculated to be 0.75%, with total offset error = 150 μV,  $R_{SENSE} = 0.5$  mΩ, and  $I_{SENSE} = 40$  A.

$$\text{Total Offset Error (\%)} = \frac{\text{Total Offset Error (V)}}{I_{SENSE} \times R_{SENSE}} \times 100\% \quad (6)$$

One method of calculating the total error is to add the gain error to the percentage contribution of the offset error. However, in this case, the gain error and the offset error do not have an influence or correlation to each other. A more statistically accurate method of calculating the total error is to use the RSS sum of the errors, as shown in Equation 7:

$$\text{Total Error (\%)} = \sqrt{\text{Total Gain Error (\%)}^2 + \text{Total Offset Error (\%)}^2} \quad (7)$$

After applying Equation 7, the total current sense error at maximum current is calculated to be 1.25%, and that is less than the design example requirement of 1.5%.

The INA180A4 (gain = 200) also has a bandwidth of 105 kHz that meets the small-signal bandwidth requirement of 80 kHz. If higher bandwidth is required, lower-gain devices can be used at the expense of either reduced output voltage range or an increased value of  $R_{\text{SENSE}}$ .

### 9.2.3 Application Curve

Figure 9-4 shows an example output response of a unidirectional configuration. The device output swing is limited by ground; therefore, the output is biased to this zero output level. The output rises above ground for positive differential input signals, but cannot fall below ground for negative differential input signals.

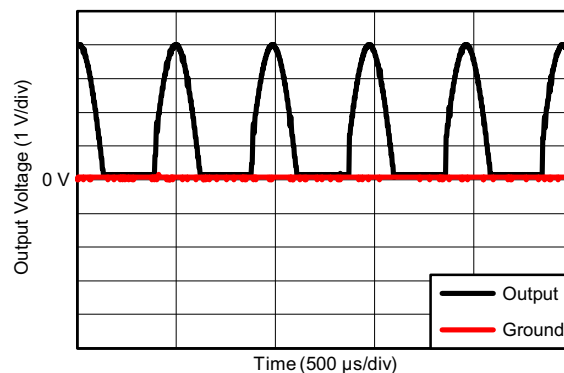


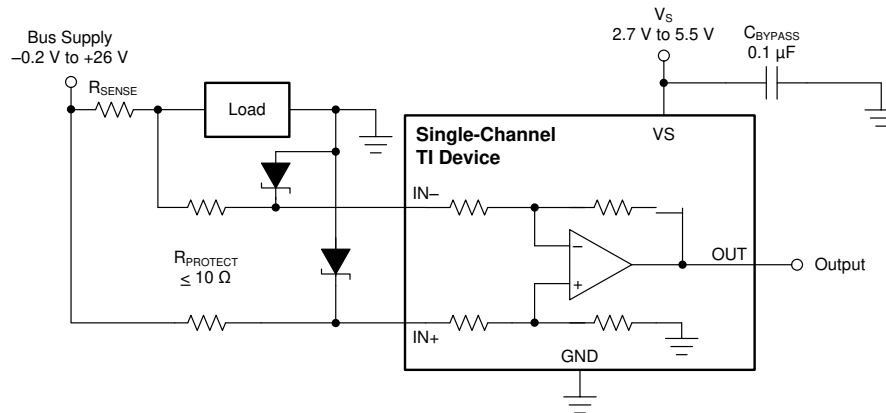
Figure 9-4. Output Response

## 9.3 Power Supply Recommendations

The input circuitry of the INAx180 accurately measures beyond the power-supply voltage,  $V_S$ . For example,  $V_S$  can be 5 V, whereas the bus supply voltage at  $IN+$  and  $IN-$  can be as high as 26 V. However, the output voltage range of the OUT pin is limited by the voltages on the  $VS$  pin. The INAx180 also withstand the full differential input signal range up to 26 V at the  $IN+$  and  $IN-$  input pins, regardless of whether or not the device has power applied at the  $VS$  pin.

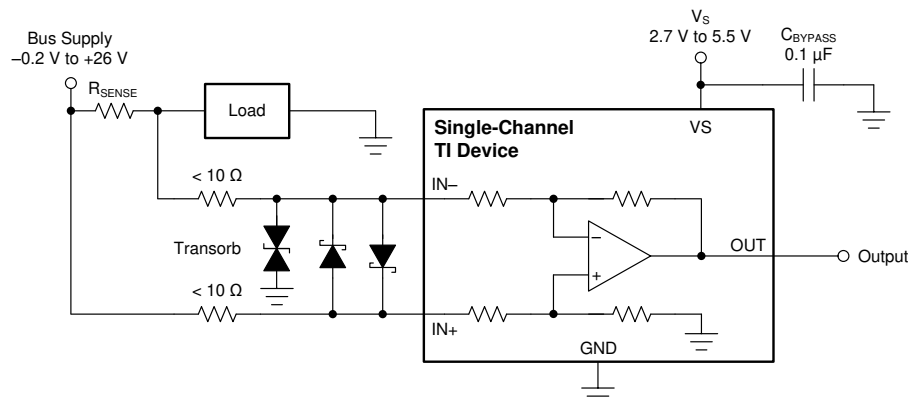
### 9.3.1 Common-Mode Transients Greater Than 26 V

With a small amount of additional circuitry, the INAx180 can be used in circuits subject to transients higher than 26 V, such as automotive applications. Use only Zener diodes or Zener-type transient absorbers (sometimes referred to as *transzorb*s)—any other type of transient absorber has an unacceptable time delay. Start by adding a pair of resistors as a working impedance for the Zener diode, as shown Figure 9-5. Keep these resistors as small as possible; most often, around 10  $\Omega$ . Larger values can be used with an effect on gain that is discussed in the [Signal Filtering](#) section. This circuit limits only short-term transients; therefore, many applications are satisfied with a 10- $\Omega$  resistor along with conventional Zener diodes of the lowest acceptable power rating. This combination uses the least amount of board space. These diodes can be found in packages as small as SOT-523 or SOD-523.



**Figure 9-5. Transient Protection Using Dual Zener Diodes**

In the event that low-power Zener diodes do not have sufficient transient absorption capability, a higher-power transzorb must be used. The most package-efficient solution involves using a single transzorb and back-to-back diodes between the device inputs, as shown in [Figure 9-6](#). The most space-efficient solutions are dual, series-connected diodes in a single SOT-523 or SOD-523 package. In either of the examples shown in [Figure 9-5](#) and [Figure 9-6](#), the total board area required by the INAx180 with all protective components is less than that of an SO-8 package, and only slightly greater than that of an MSOP-8 package.



**Figure 9-6. Transient Protection Using a Single Transzorb and Input Clamps**

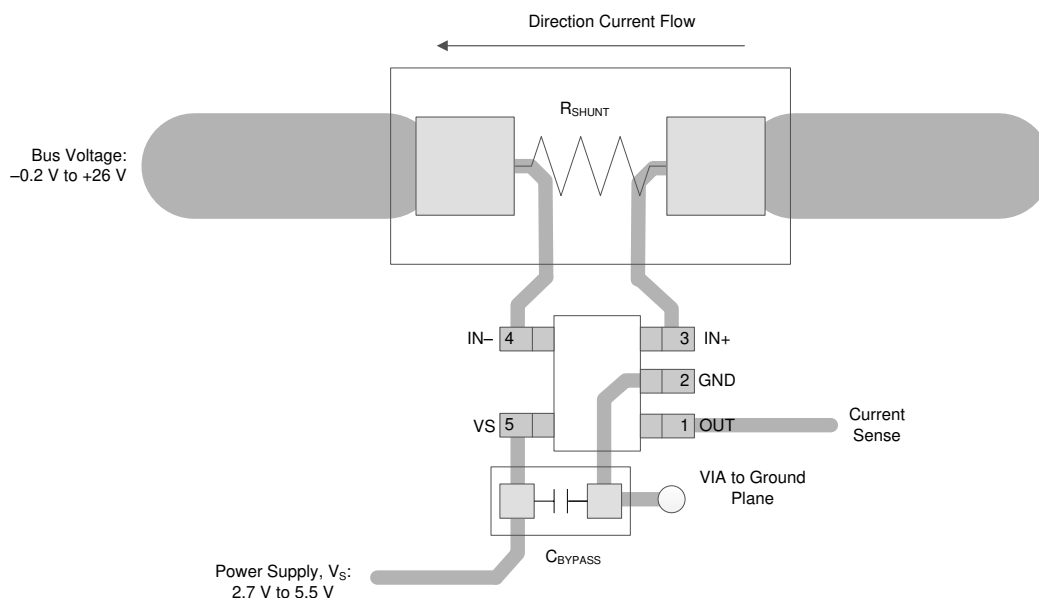
For a reference design example, see [Current Shunt Monitor With Transient Robustness Reference Design](#).

## 9.4 Layout

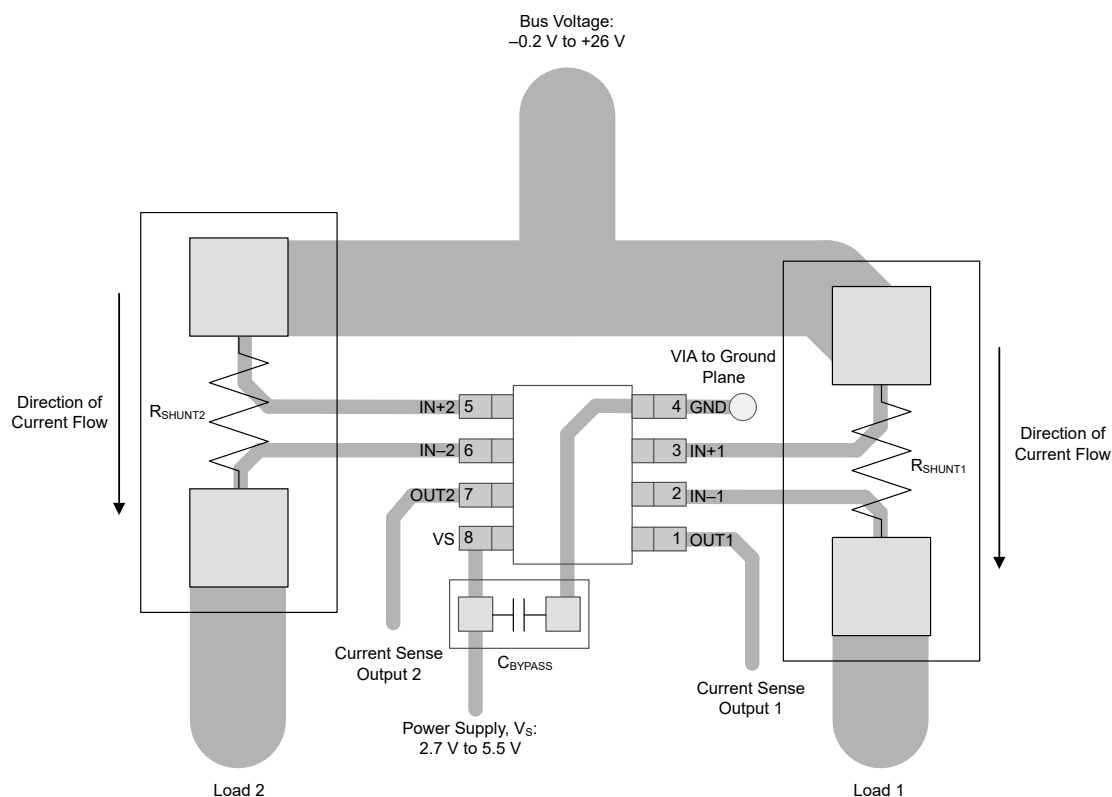
### 9.4.1 Layout Guidelines

- Connect the input pins to the sensing resistor using a Kelvin or 4-wire connection. This connection technique makes sure that only the current-sensing resistor impedance is detected between the input pins. Poor routing of the current-sensing resistor commonly results in additional resistance present between the input pins. Given the very low ohmic value of the current resistor, any additional high-current carrying impedance can cause significant measurement errors.
- Place the power-supply bypass capacitor as close as possible to the device power supply and ground pins. The recommended value of this bypass capacitor is 0.1 μF. Additional decoupling capacitance can be added to compensate for noisy or high-impedance power supplies.
- When routing the connections from the current sense resistor to the device, keep the trace lengths as close as possible in order to minimize any impedance mismatch.

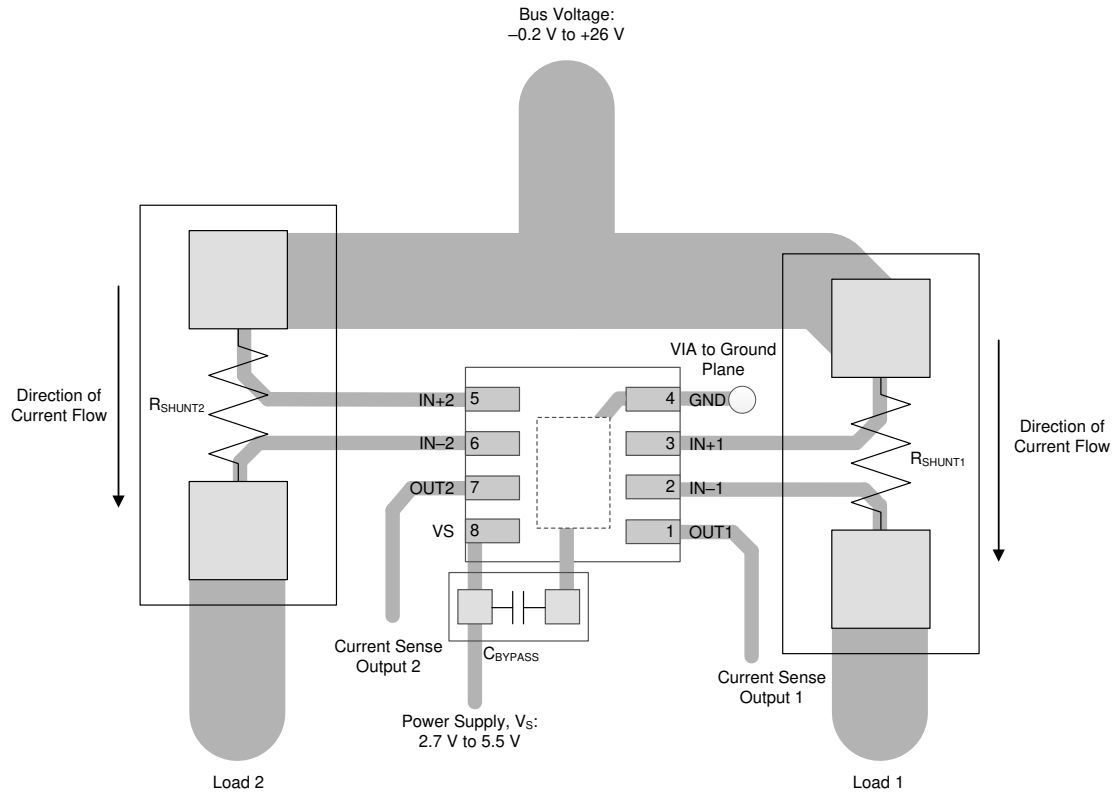
## 9.4.2 Layout Examples



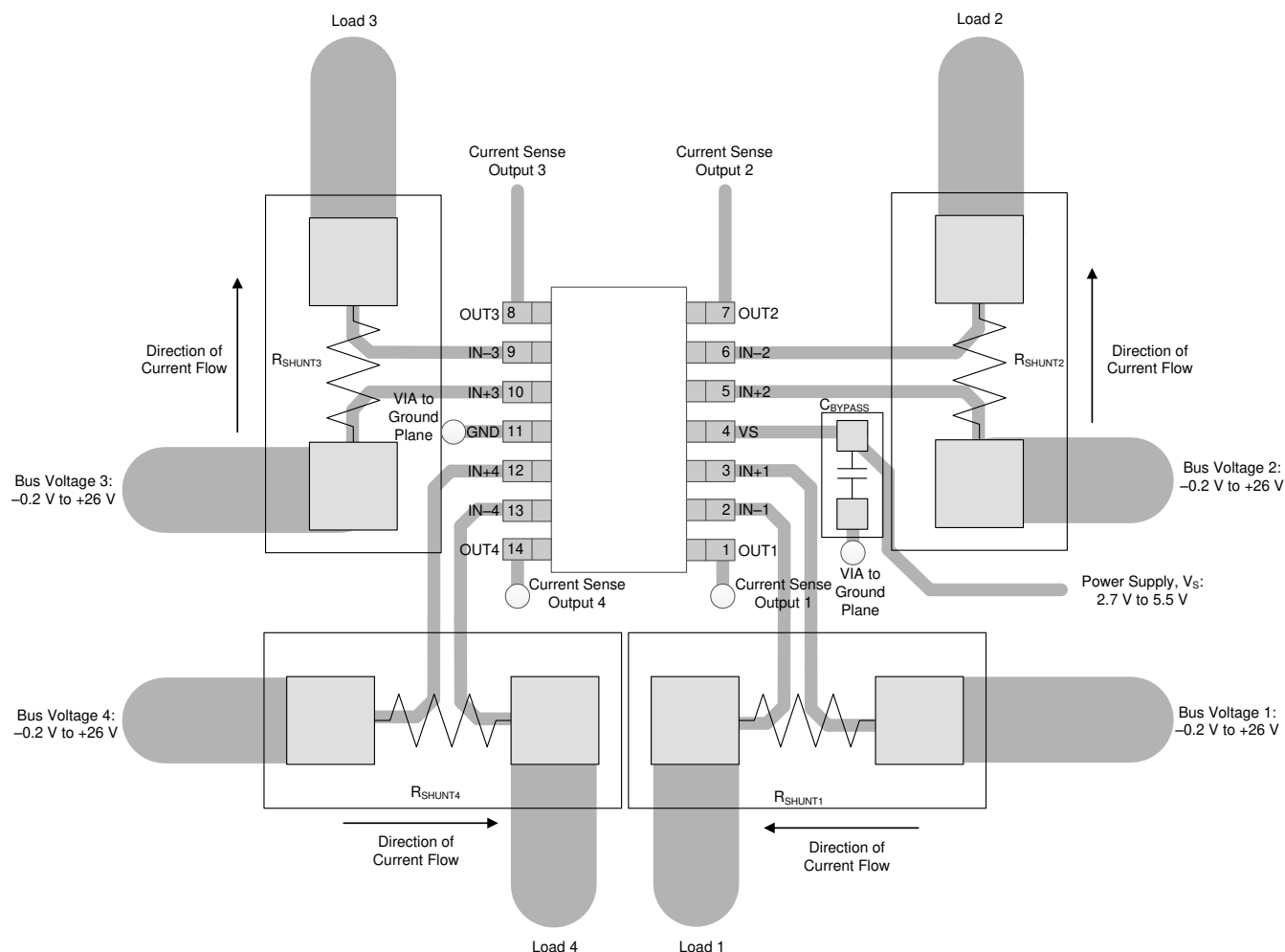
**Figure 9-7. Single-Channel Recommended Layout (Pinout A)**



**Figure 9-8. Dual-Channel Recommended Layout (VSSOP)**



**Figure 9-9. Dual-Channel Recommended Layout (WSN)**



**Figure 9-10. Quad-Channel Recommended Layout**

## 10 Device and Documentation Support

### 10.1 Documentation Support

#### 10.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [INA180-181EVM User's Guide](#)
- Texas Instruments, [INA2180-2181EVM User's Guide](#)
- Texas Instruments, [INA4180-4181EVM User's Guide](#)

### 10.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](#). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 10.3 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 10.4 Trademarks

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### 10.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 10.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| INA180A1IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 18ID                    | <a href="#">Samples</a> |
| INA180A1IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 18ID                    | <a href="#">Samples</a> |
| INA180A2IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1A8D                    | <a href="#">Samples</a> |
| INA180A2IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1A8D                    | <a href="#">Samples</a> |
| INA180A3IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1A9D                    | <a href="#">Samples</a> |
| INA180A3IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1A9D                    | <a href="#">Samples</a> |
| INA180A4IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1AAD                    | <a href="#">Samples</a> |
| INA180A4IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1AAD                    | <a href="#">Samples</a> |
| INA180B1IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 18RD                    | <a href="#">Samples</a> |
| INA180B1IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 18RD                    | <a href="#">Samples</a> |
| INA180B2IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1ABD                    | <a href="#">Samples</a> |
| INA180B2IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1ABD                    | <a href="#">Samples</a> |
| INA180B3IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1ACD                    | <a href="#">Samples</a> |
| INA180B3IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1ACD                    | <a href="#">Samples</a> |
| INA180B4IDBVR    | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1ADD                    | <a href="#">Samples</a> |
| INA180B4IDBVT    | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1ADD                    | <a href="#">Samples</a> |
| INA2180A1IDGKR   | ACTIVE        | VSSOP        | DGK             | 8    | 2500        | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1CX6                    | <a href="#">Samples</a> |
| INA2180A1IDGKT   | ACTIVE        | VSSOP        | DGK             | 8    | 250         | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1CX6                    | <a href="#">Samples</a> |
| INA2180A1IDSGR   | ACTIVE        | WSO          | DSG             | 8    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25EY                    | <a href="#">Samples</a> |
| INA2180A1IDSGT   | ACTIVE        | WSO          | DSG             | 8    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25EY                    | <a href="#">Samples</a> |



| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| INA2180A2IDGKR   | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1CZ6                    | <a href="#">Samples</a> |
| INA2180A2IDGKT   | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1CZ6                    | <a href="#">Samples</a> |
| INA2180A2IDSGR   | ACTIVE        | WSO          | DSG                | 8    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25FY                    | <a href="#">Samples</a> |
| INA2180A2IDSGT   | ACTIVE        | WSO          | DSG                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25FY                    | <a href="#">Samples</a> |
| INA2180A3IDGKR   | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1D16                    | <a href="#">Samples</a> |
| INA2180A3IDGKT   | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1D16                    | <a href="#">Samples</a> |
| INA2180A3IDSGR   | ACTIVE        | WSO          | DSG                | 8    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25GY                    | <a href="#">Samples</a> |
| INA2180A3IDSGT   | ACTIVE        | WSO          | DSG                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25GY                    | <a href="#">Samples</a> |
| INA2180A4IDGKR   | ACTIVE        | VSSOP        | DGK                | 8    | 2500           | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1D26                    | <a href="#">Samples</a> |
| INA2180A4IDGKT   | ACTIVE        | VSSOP        | DGK                | 8    | 250            | RoHS & Green    | NIPDAUAG   SN                        | Level-2-260C-1 YEAR  | -40 to 125   | 1D26                    | <a href="#">Samples</a> |
| INA2180A4IDSGR   | ACTIVE        | WSO          | DSG                | 8    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25HY                    | <a href="#">Samples</a> |
| INA2180A4IDSGT   | ACTIVE        | WSO          | DSG                | 8    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 25HY                    | <a href="#">Samples</a> |
| INA4180A1IPWR    | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | 4180A1                  | <a href="#">Samples</a> |
| INA4180A2IPWR    | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | 4180A2                  | <a href="#">Samples</a> |
| INA4180A3IPWR    | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | 4180A3                  | <a href="#">Samples</a> |
| INA4180A4IPWR    | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | 4180A4                  | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF INA180, INA2180, INA4180 :**

- Automotive : [INA180-Q1](#), [INA2180-Q1](#), [INA4180-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| INA180A1IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180A1IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180A2IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180A2IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180A3IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180A3IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180A4IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180A4IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B1IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B1IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B2IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B2IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B3IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B3IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B4IDBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| INA180B4IDBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| INA2180A1IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A1IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A1IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A1IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A1IDSGR | WSON         | DSG             | 8    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA2180A1IDSGT | WSON         | DSG             | 8    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA2180A2IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A2IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A2IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A2IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A2IDSGR | WSON         | DSG             | 8    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA2180A2IDSGT | WSON         | DSG             | 8    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA2180A3IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A3IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A3IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A3IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A3IDSGR | WSON         | DSG             | 8    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA2180A3IDSGT | WSON         | DSG             | 8    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA2180A4IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A4IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A4IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A4IDGKT | VSSOP        | DGK             | 8    | 250  | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| INA2180A4IDSGR | WSON         | DSG             | 8    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA2180A4IDSGT | WSON         | DSG             | 8    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| INA4180A1IPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| INA4180A2IPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| INA4180A3IPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| INA4180A4IPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| INA180A1IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180A1IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA180A2IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180A2IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA180A3IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180A3IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA180A4IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180A4IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA180B1IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180B1IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA180B2IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180B2IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA180B3IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180B3IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA180B4IDBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| INA180B4IDBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| INA2180A1IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |
| INA2180A1IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| INA2180A1IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A1IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A1IDSGR | WSO          | DSG             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| INA2180A1IDSGT | WSO          | DSG             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| INA2180A2IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |
| INA2180A2IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |
| INA2180A2IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A2IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A2IDSGR | WSO          | DSG             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| INA2180A2IDSGT | WSO          | DSG             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| INA2180A3IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |
| INA2180A3IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |
| INA2180A3IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A3IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A3IDSGR | WSO          | DSG             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| INA2180A3IDSGT | WSO          | DSG             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| INA2180A4IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |
| INA2180A4IDGKR | VSSOP        | DGK             | 8    | 2500 | 366.0       | 364.0      | 50.0        |
| INA2180A4IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A4IDGKT | VSSOP        | DGK             | 8    | 250  | 366.0       | 364.0      | 50.0        |
| INA2180A4IDSGR | WSO          | DSG             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| INA2180A4IDSGT | WSO          | DSG             | 8    | 250  | 210.0       | 185.0      | 35.0        |
| INA4180A1IPWR  | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| INA4180A2IPWR  | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| INA4180A3IPWR  | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| INA4180A4IPWR  | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |

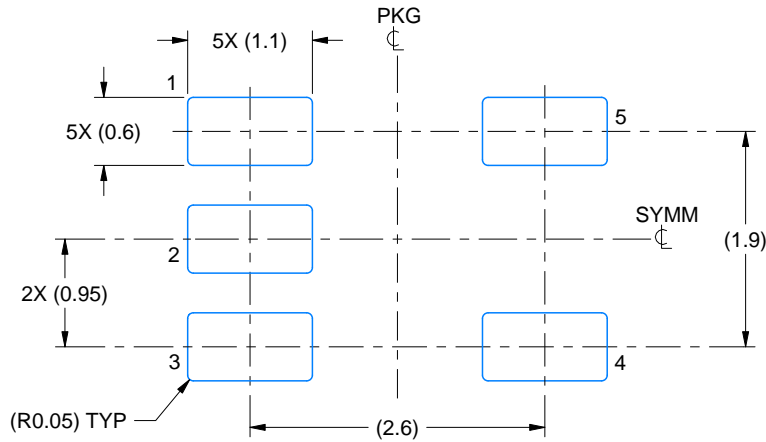


# EXAMPLE BOARD LAYOUT

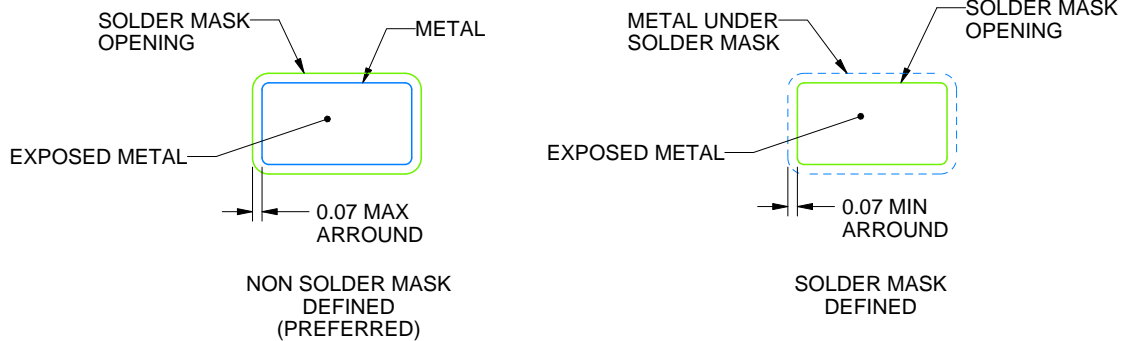
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/F 06/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

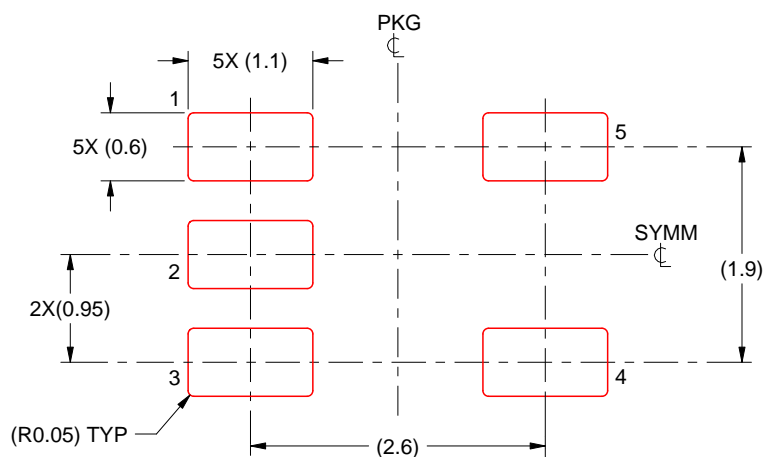


## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/F 06/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## DGK (S-PDSO-G8)

## PLASTIC SMALL-OUTLINE PACKAGE



4073329/E 05/06

## NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.

DGK (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## GENERIC PACKAGE VIEW

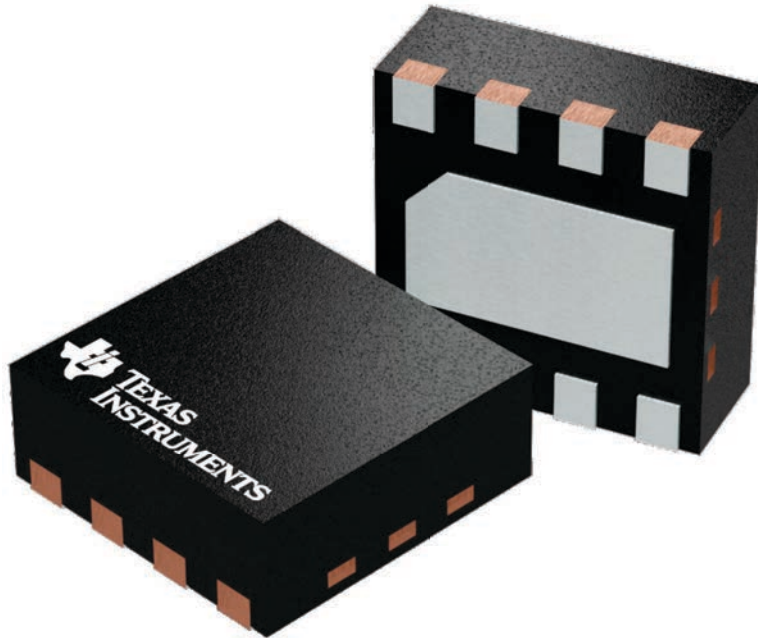
**DSG 8**

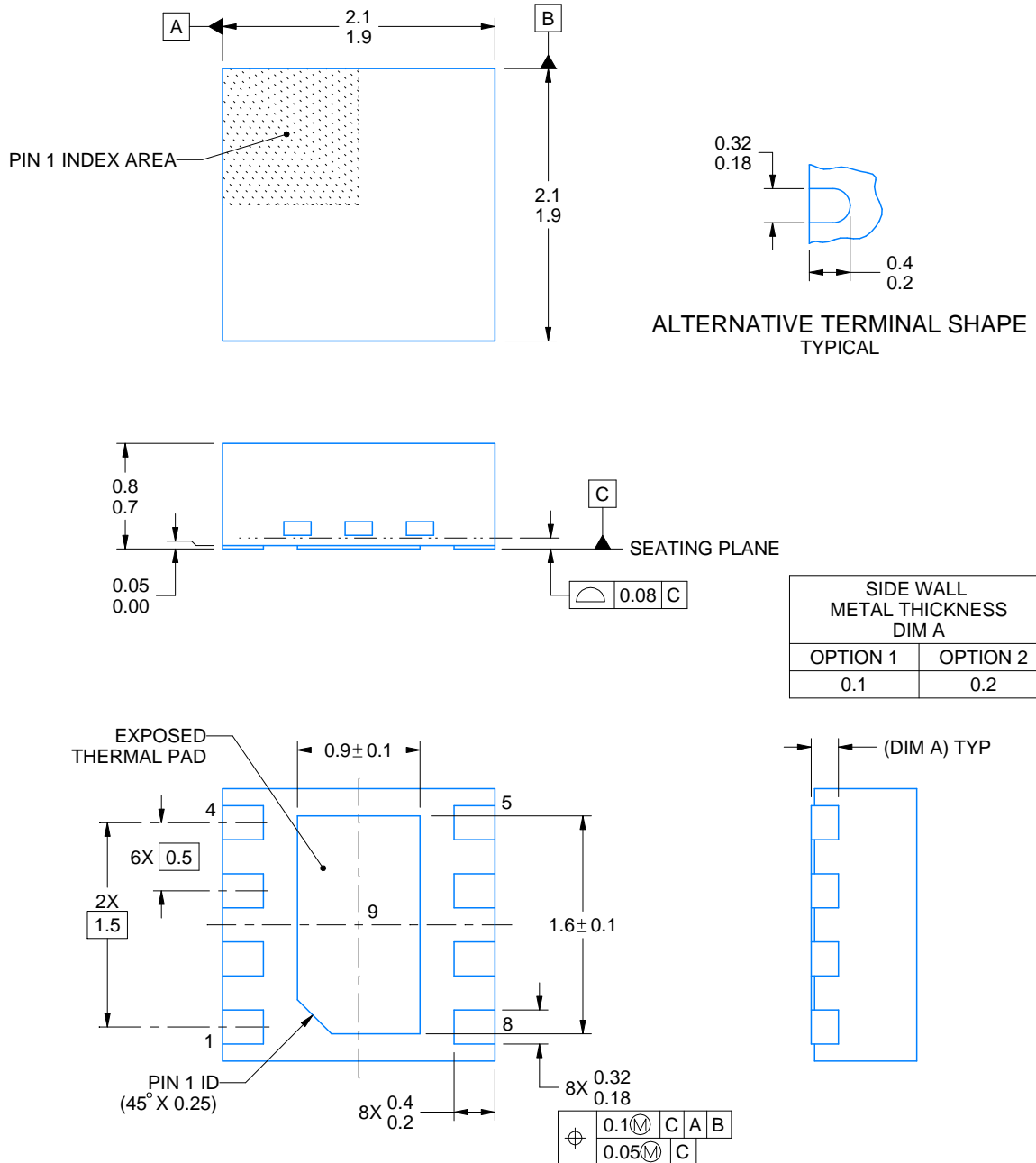
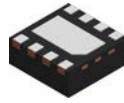
**WSON - 0.8 mm max height**

2 x 2, 0.5 mm pitch

PLASTIC SMALL OUTLINE - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.





4218900/E 08/2022

**NOTES:**

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



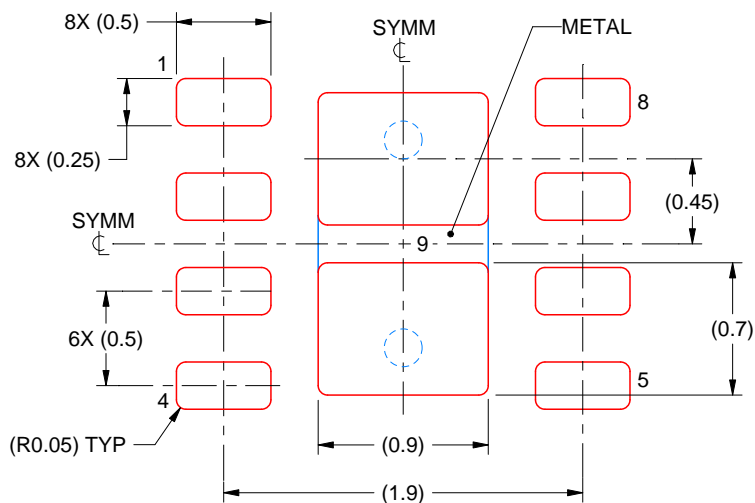


## EXAMPLE STENCIL DESIGN

DSG0008A

WSN - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 9:  
87% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:25X

4218900/E 08/2022

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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